

# **GR5525** Developer Guide

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Shenzhen Goodix Technology Co., Ltd.

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## Preface

#### Purpose

This document introduces the Software Development Kit (SDK) of the Goodix GR5525 Bluetooth Low Energy (Bluetooth LE) System-on-Chip (SoC) and Keil for program development and debugging, to help you quickly get started with secondary development of Bluetooth LE applications.

#### Audience

This document is intended for:

- GR5525 user
- GR5525 developer
- GR5525 tester
- Technical writer

#### **Release Notes**

This document is the second release of *GR5525 Developer Guide*, corresponding to GR5525 SoC series.

#### **Revision History**

Version	Date	Description
1.0	2023-08-30	Initial release
1.1	2024-03-29	Optimized some descriptions.

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## G@DiX

## **1** Introduction

The Goodix GR5525 series is a single-mode low-power System-on-Chip (SoC) that supports Bluetooth 5.3. It can be configured as a Broadcaster, an Observer, a Central, or a Peripheral, and supports the combination of all the above roles, making it an ideal choice for Internet of Things (IoT) and smart wearable devices.

Based on Arm<sup>®</sup> Cortex<sup>®</sup>-M4F CPU core, the GR5525 series integrates Bluetooth 5.3 Protocol Stack, a 2.4 GHz RF transceiver, on-chip programmable Flash memory, RAM, and multiple peripherals.

The GR5525 series comes in two package choices: QFN56 and QFN68 packages. The specific configurations are listed below.

GR5525 Series	GR5525RGNI	GR5525IGNI	GR5525IENI	GR552510NI
СРИ	Cortex <sup>®</sup> -M4F	Cortex <sup>®</sup> -M4F	Cortex <sup>®</sup> -M4F	Cortex <sup>®</sup> -M4F
RAM	256 КВ	256 КВ	256 КВ	256 КВ
SiP Flash	1 MB	1 MB	512 KB	N/A
I/O Number	50	39	39	39
I/O Voltage	1.8 V-3.6 V	1.8 V–3.6 V	1.8 V–3.6 V	In line with Flash voltage
Package (mm)	QFN68 (7.0 x 7.0 x 0.85)	QFN56 (7.0 x 7.0 x 0.75)	QFN56 (7.0 x 7.0 x 0.75)	QFN56 (7.0 x 7.0 x 0.75)

		Table 1-1	Configuration	of	GR5525	series
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## 1.1 GR5525 SDK

The GR5525 Software Development Kit (SDK) provides comprehensive software development support for GR5525 SoCs. The SDK contains Bluetooth LE APIs, System APIs, peripheral drivers, a tool for debugging and download, project example code, and related user documents.

The GR5525 SDK version mentioned in this document is applicable to all GR5525 SoCs.

## **1.2 Bluetooth LE Protocol Stack**

The Bluetooth LE Protocol Stack (Bluetooth LE Stack) architecture is as shown in the figure below.



(	Generic Attribute Profile (GATT)	Generic Access Profile (GAP)	
	Attribute Protocol (ATT)	Security Manager (SM)	
Logical Link Control and Adaptation Protocol (L2CAP)			
	Host	Controller Interface (HCI)	
Contro	ller		
		Link Layer (LL)	
	Physical Layer (PHY)		

Figure 1-1 Bluetooth LE Stack architecture

The Bluetooth LE Stack consists of the Controller, the Host Controller Interface (HCI), and the Host.

#### Controller

- Physical Layer (PHY): Supports 1-Mbps and 2-Mbps adaptive frequency hopping and Gaussian Frequency Shift Keying (GFSK).
- Link Layer (LL): Controls the RF state of devices. Devices are in one of the following five states, and can switch between the states on demand: Standby, Advertising, Scanning, Initiating, and Connection.

#### HCI

• HCI: Enables communication between Host and Controller, supported by software interfaces or standard hardware interfaces; for example, UART, Secure Digital (SD), or USB. HCI commands and events are transferred between Host and Controller through HCI.

#### Host

- Logical Link Control and Adaptation Protocol (L2CAP): Provides channel multiplexing and data segmentation and reassembly services for upper layers. It also supports logic end-to-end data communication.
- Security Manager (SM): Defines pairing and key distribution methods, providing upper-layer protocol stacks and applications with end-to-end secure connection and data exchange functionalities.
- Generic Access Profile (GAP): Provides upper-layer applications and profiles with interfaces to communicate and interact with protocol stacks, fulfilling functionalities such as advertising, scanning, connection initiation, service discovery, connection parameter update, secure process initiation, and response.

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- Attribute Protocol (ATT): Defines service data interaction protocols between a server and a client.
- Generic Attribute Profile (GATT): Based on the top of ATT, it defines a series of communication procedures for upper-layer applications, profiles, and services to exchange service data between GATT Client and GATT Server.

### **△**Tip:

For more information about Bluetooth LE technologies and protocols, visit the Bluetooth SIG official website: <u>https://www.bluetooth.com</u>.

Specifications of GAP, SM, L2CAP, and GATT are provided in *Bluetooth Core Spec*. Specifications of other profiles/ services at the Bluetooth LE application layer are available on the GATT Specs page. Assigned numbers, IDs, and code which may be used by Bluetooth LE applications are listed on the Assigned Numbers page.

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# 2 GR5525 Bluetooth LE Software Platform

The GR5525 SDK is designed for GR5525 SoCs, to help users develop Bluetooth LE applications. It integrates Bluetooth LE 5.3 APIs, System APIs, and peripheral driver APIs, with various example projects and instruction documents for Bluetooth and peripheral applications. Application developers are able to quickly develop and iterate products based on example projects in the GR5525 SDK.

## 2.1 Hardware Architecture

The GR5525 hardware architecture is shown as follows.

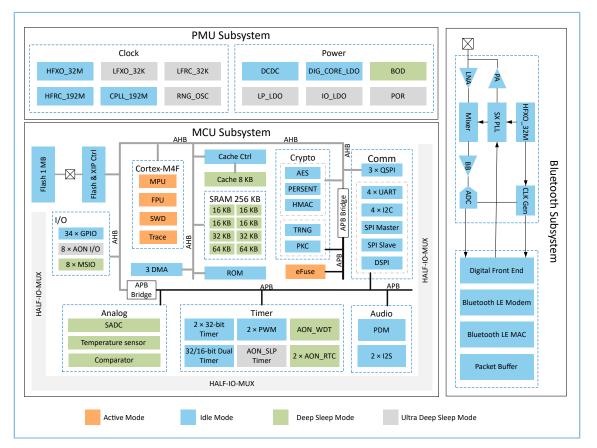


Figure 2-1 GR5525 hardware architecture

- Bluetooth subsystem:
  - Include a 2.4 GHz RF transceiver and a digital communication controller, both supporting Bluetooth LE 5.3.
- MCU subsystem:
  - ° Include an Arm<sup>®</sup> Cortex<sup>®</sup>-M4F CPU core, memories, and peripherals.
  - Security modules supports security application and secure boot implementation.
- Power Management Unit (PMU) subsystem:
  - Power supply for the whole SoC, including internal modules and peripherals

 Support ultra deep sleep mode in standby state and control the power state of the system or peripherals by HFRC\_192M, RNG\_OSC, LFRC\_32K, wake-up GPIOs (Wake-up), low-power comparator (LP Comp.) and power state controller (Power Sequencer).

#### **△**Tip:

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For more details about GR5525 modules, refer to GR5525 Datasheet.

## 2.2 Software Architecture

The software architecture of GR5525 SDK is shown below.

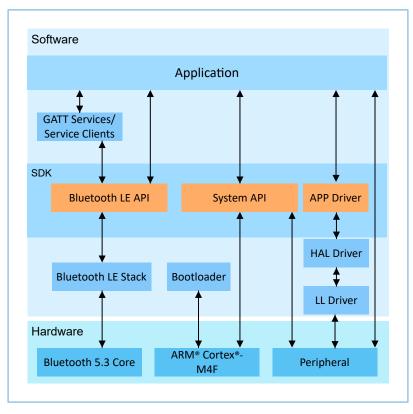


Figure 2-2 GR5525 software architecture

#### Bootloader

A boot program built in GR5525 SoCs, used for GR5525 software and hardware environment initialization, and to check and start applications

Bluetooth LE Stack

The core to implement Bluetooth LE protocols. It consists of Controller, HCI, and Host protocols (including ATT, L2CAP, GAP, SM, and GATT), and supports roles of Broadcaster, Observer, Peripheral, and Central.

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#### HAL Driver

Hardware Abstraction Layer (HAL) drivers; the HAL Driver layer is between the APP Driver layer and the LL Driver layer. HAL drivers offer a set of standard APIs, to allow the APP Driver layer to access the LL peripheral resources by calling HAL APIs.

#### Dote:

Generally, HAL APIs are used for developing LL drivers and system services, not for developing common applications. Therefore, it is not recommended for developers to directly call HAL APIs.

LL Driver

Low Layer (LL) drivers which control and manage peripherals by registers

Bluetooth LE SDK

SDK that provides easy-to-use Bluetooth LE APIs, system APIs, and APP driver APIs.

- Bluetooth LE APIs: Includes L2CAP, GAP, SM, and GATT APIs.
- System APIs: Provides APIs for Non-volatile Data Storage (NVDS), Device Firmware Update (DFU), system power management, and generic system-level access.
- APP driver APIs: Provides definitions for APIs of common peripherals such as UART, I2C, and ADC. APP driver APIs call HAL/LL APIs to enable the corresponding functionalities.
- Application

The SDK provides abundant Bluetooth and peripheral example projects. Each project contains compiled binary files; you can download these files to GR5525 SoCs for operation and test. GRToolbox (Android) in the SDK provides rich functionalities to allow users to test most Bluetooth applications with ease.

## 2.3 Memory Mapping

The memory mapping of a GR5525 SoC is shown below.

0x400F FFFF	Bluetooth LE
0x400E 0000	(128 KB)
0x400D FFFF	Reserved
	(708 KB)
0x4002 F000 0x4002 EFFF	
	DSPI (A KD)
0x4002 E000	(4 KB)
0x4002 DFFF	Reserved
0x4002 4000	(40 KB)
0x4002 3FFF	QSPI M2 REG
0x4002 3000	(4 KB)
0x4002 2FFF	QSPI M1 REG
0x4002 2000	(4 KB)
0x4002 1FFF	QSPI MO REG
0x4002 1000	(4 KB)
0x4002 0FFF	Reserved
01001 0000	(20 KB)
0x4001 C000 0x4001 BFFF	DMA
0x4001 BFFF 0x4001 9000	DMA (12 KB)
	. ,
0x4001 8FFF	Security (20 KB)
0x4001 4000 0x4001 3FFF	
0x4001 3000	Reserved (4 KB)
0x4001 3000 0x4001 2FFF	(4 (0)
0,4001 2111	GPIO Ctrl
0x4001 0000	(12 KB)
0x4000 FFFF	APB Subsys
0x4000 0000	(64 KB)
0x3FFF FFFF	
0.0111111	Reserved
0x2200 0000	(480 MB)
0x21FF FFFF	QSPI M1 XIP Alias
0x2004 0000	(31.75 MB)[*]
0x2003 FFFF	CDANA
	SRAM (256 KB)
0x2000 0000	(/
0x1FFF FFFF	Reserved
0x1C00 0000 0x1BFF FFFF	(64 MB)
0x1800 0000	QSPI M2 XIP
0x1800 0000 0x17FF FFFF	(64 MB)
0x1400 0000	QSPI M1 XIP (64 MB)
0x1400 0000 0x13FF FFFF	. ,
	QSPI M0 XIP
0x1000 0000	(64 MB)
OxOFFF FFFF	Reserved (206 MB)
0x0320 0000 0x031F FFFF	(200 110)
OVODTL LLLL	ExFlash Alias
0x0220 0000	(16 MB)
0x021F FFFF	Reserved
0x0120 0000	(16 MB)
0x011F FFFF	
	ExFlash
0x0020 0000	(16 MB)
0x001F FFFF	Reserved
0x0014 0000	(768 KB)
0x0013 FFFF	SRAM Alias
	(256 KB)
0x0010 0000	
0x000F FFFF	Reserved
0x0005 0000	(704 KB)
0x0004 FFFF	ROM
	(320 KB)
0x0000 0000	

Figure 2-3 GR5525 memory mapping



- RAM: 0x0010\_0000 to 0x0013\_FFFF, or 0x2000\_0000 to 0x2003\_FFFF; 256 KB in total
  - 0x2000\_0000 to 0x2003\_FFFF: bit field operations supported, mapping to the region from 0x2200\_0000 to 0x227F\_FFFF, in which atomic operations are supported. Variables of the SDK including RW, ZI, HEAP, and STACK are in this range.
  - <sup>°</sup> 0x0010\_0000 to 0x0013\_FFFF: This region features higher access efficiency thanks to the Cortex<sup>®</sup>-M4F architecture. Therefore, RAM\_CODE is in this area.

#### **Note**:

QSPI0, QSPI1, and QSPI2 support the Execute in Place (XIP) mode, which allows mapping of address from QSPI Flash to memories, enabling direct operations on memories.

- Flash: 0x0020\_0000 to 0x011F\_FFFF or 0x0220\_0000 to 0x031F\_FFFF, 16 MB in total
  - 0x0020\_0000 to 0x011F\_FFFF: Stores code and unencrypted data.
  - 0x0220\_0000 to 0x031F\_FFFF: Stores encrypted data.

#### 🛄 Note:

Internal Flash of GR5525 SoCs is 1 MB, from 0x0020\_0000 to 0x002F\_FFFF.

### 2.4 Flash Memory Mapping

GR5525 packages an external erasable Flash memory, which supports XQSPI bus interface. This Flash memory physically consists of several 4 KB Flash sectors; it can be logically divided into storage areas for different purposes based on application scenarios.

The Flash memory layout for typical GR5525 application scenarios is shown below.

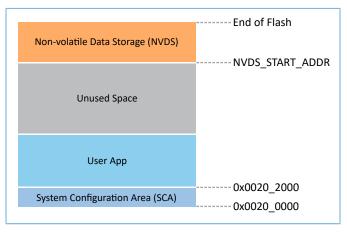


Figure 2-4 Flash memory layout

- System Configuration Area (SCA): an area to store configurations such as system boot parameters
- User App: an area to store application firmware

- Unused Space: a free area for developers. For example, developers can store new application firmware in the Unused Space temporarily during DFU.
- NVDS: non-volatile data storage area

#### 🛄 Note:

By default, NVDS occupies the last two sectors of Flash memory. You can configure the start address of NVDS and the number of occupied sectors according to Flash memory layout of products. For more information about the configuration, refer to "Section 4.3.2.1 Configuring custom\_config.h".

The start address of NVDS shall be aligned with that of the Flash sectors.

### 2.4.1 SCA

SCA is in the first two sectors (8 KB in total; 0x0020\_0000 to 0x0020\_2000) of Flash memory. It mainly stores flags and other system configuration parameters used during system boot.

During firmware download, the download algorithm or GProgrammer will generate Image Info based on the BUILD\_IN\_APP\_INFO structure in the application firmware, and program the Image Info (stored in SCA) to Flash along with the application firmware. During system boot, Bootloader will check the boot information in SCA, and then jump to the entry address of the firmware if the check passes.

The BUILD\_IN\_APP\_INFO structure is defined and configured as follows:

#### **Tip**:

The BUILD\_IN\_APP\_INFO structure is in SDK\_Folder\platform\soc\common\gr\_platform.c, and SDK\_Folder is the root directory of GR5525 SDK.

```
const APP_INFO_t BUILD_IN_APP_INFO __attribute__((section(".app_info"))) =
#endif
{
    .app_pattern = APP_INFO_PATTERN_VALUE,
    .app_info_version = APP_INFO_VERSION,
    .chip_ver = CHIP_VER,
    .load_addr = APP_CODE_LOAD_ADDR,
    .run_addr = APP_CODE_RUN_ADDR,
    .app_info_sum = CHECK_SUM,
    .check_img = BOOT_CHECK_IMAGE,
    .boot_delay = BOOT_LONG_TIME,
    .sec_cfg = SECURITY_CFG_VAL,
#ifdef APP_INFO_COMMENTS
    .comments = APP_INFO_COMMENTS,
#endif
};
```

- app\_pattern: a fixed value 0x47525858
- app\_info\_version: firmware version information, corresponding to APP\_INFO\_VERSION
- chip\_ver: version of the SoC that the firmware runs on, corresponding to CHIP\_VER in custom\_config.h
- load\_addr: firmware load address, corresponding to APP\_CODE\_LOAD\_ADDR in custom\_config.h

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- run\_addr: firmware run address, corresponding to APP\_CODE\_RUN\_ADDR in custom\_config.h
- app\_info\_sum: checksum of firmware information, which is automatically calculated by CHECK\_SUM
- check\_img: system boot configuration parameter, corresponding to BOOT\_CHECK\_IMAGE in *custom\_config.h*. When check\_img is set to 1, Bootloader will check the firmware at booting.
- boot\_delay: boot configuration parameter, corresponding to BOOT\_LONG\_TIME in *custom\_config.h*. When boot\_delay is set to 1, the system cold boot will be launched after a one-second delay.
- sec\_cfg: security configuration parameter, reserved
- comments: firmware information, up to 12 bytes

The SCA layout is shown below.

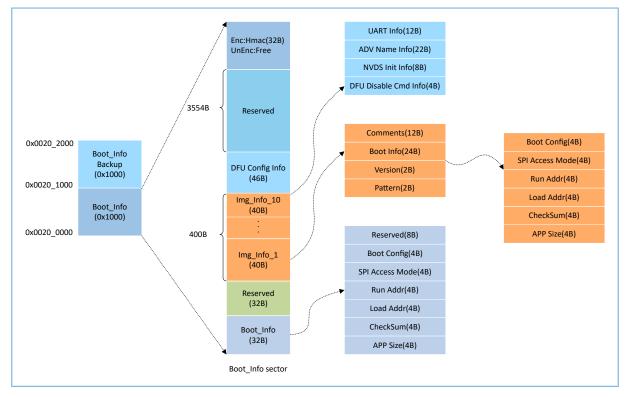


Figure 2-5 SCA layout

- Boot\_Info and Boot\_Info Backup store the same information. The latter is the backup of the Boot\_Info.
  - In non-security mode, the Bootloader obtains boot information from Boot\_Info by default.
  - In security mode, the Bootloader checks Boot\_Info first; if the check fails, the Bootloader checks Boot\_Info
     Backup and obtains boot information from it.
- The firmware boot information is stored in the Boot\_Info (32 B) area. During system boot, Bootloader will check the boot information, and then jump to the entry address of the firmware if the check passes.
  - Boot Config: This area stores the system boot configuration information.

- SPI Access Mode: This area stores the SPI access mode configuration. It is a fixed configuration of the system and cannot be modified.
- Run Addr: Indicates the firmware run address, corresponding to run\_addr of BUILD\_IN\_APP\_INFO.
- Load Addr: Indicates the firmware load address, corresponding to load\_addr of BUILD\_IN\_APP\_INFO.
- CheckSum: This area stores the firmware checksum which is calculated automatically by the download algorithm after firmware is generated.
- APP Size: This area stores the firmware size which is calculated automatically by the download algorithm after firmware is generated.
- Up to 10 pieces of firmware information can be stored in Img\_Info areas. Firmware information is stored in Img\_Info areas when you use GProgrammer to download firmware or update firmware in DFU mode.
  - Comments: This area stores the descriptive information (up to 12 characters) about firmware. Every time a firmware file is generated, the file name will be saved in the Comments area by the download algorithm.
  - Boot Info (24 B): This area stores the firmware boot information which is the same as the low 24-byte information in the Boot\_Info (32 B) area mentioned above.
  - Version: This area stores the firmware version, corresponding to VERSION in the *custom\_config.h*.
  - Pattern: This area stores a fixed value 0x4744.
- The DFU Config Info area stores configurations of DFU module in ROM#
  - UART Info: This area stores UART configurations of DFU module, including state bit, baud rate, and GPIO configurations.
  - ADV Name Info: This area stores advertising configurations of DFU module, including state bit, advertising name, and advertising length.
  - NVDS Init Info: This area stores initialization configurations of NVDS system in DFU module, including state bit, NVDS area size, and start address.
  - DFU Disable Cmd Info: This area stores DFU disable command configurations of DFU module, including state bit and Disable DFU Cmd (2 B, set as Bitmask). You can set the Disable DFU Cmd value to disable a DFU command.
- The HMAC area stores the HMAC check value. This area is valid only in security mode.

### 2.4.2 NVDS

NVDS is a lightweight logical data storage system based on Flash HAL. NVDS is located in the Flash memory and data in it will not get lost in power-off state. By default, NVDS uses the last two sectors of the Flash memory. You can also configure the number of Flash sectors to be occupied. In NVDS, the last sector is for defragmentation, and the other sector(s) for data storage.

NVDS is an ideal choice to store small data blocks, for example, application configuration parameters, calibration data, states, and user information. Bluetooth LE Stack stores parameters such as device binding parameters in NVDS.

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#### NVDS features:

- Each storage item (TAG) has a unique TAG ID. User applications can read and change data according to TAG IDs, regardless of physical storage addresses.
- It is optimized based on medium characteristics of Flash memory and supports data check, word alignment, defragmentation, and erase/write balance.
- The size and start address of NVDS are configurable. Compared with Flash memory which is made up of 4 KB sectors, NVDS can be in several sectors as configured. Make sure the start address of NVDS is 4 KB aligned.

#### 🛄 Note:

- You can configure the start address and size of the NVDS area by adding the NVDS\_START\_ADDR macro and modifying the NVDS\_NUM\_SECTOR macro respectively in *custom\_config.h*.
- Bluetooth LE Stack and the application share the same NVDS storage area. However, TAG ID namespace is divided into different categories. You can only use the TAG ID name category assigned to an application.
  - Applications have to use NV\_TAG\_APP(idx) to obtain the TAG ID of application data. The TAG ID is used as an NVDS API parameter.
  - Applications cannot use idx as the NVDS API parameter directly. The idx value ranges from 0x4000 to 0x7FFF.
- Before running an application for the first time, you can use GProgrammer to write the initial TAG ID value used by Bluetooth LE Stack and the application to NVDS.
- If you specify an NVDS area, instead of using the default NVDS area in the GR5525 SDK, make sure the start address of the NVDS area configured in GProgrammer is 4 KB aligned.

Data stored in NVDS is in the format below.

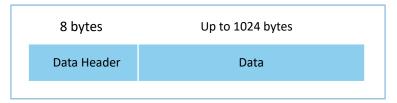


Figure 2-6 Data format in NVDS

Details of data header are described below.

#### Table 2-1 Data header format

Byte	Name	Description
0–1	tag	Data tag
2–3	len	Data length
4-4	checksum	Checksum of data header
5–5	value_cs	Checksum of data

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Byte	Name	Description
6–7	reserved	Reserved bits

GR5525 SDK provides the following NVDS APIs to allow developers to manipulate non-volatile data in Flash.

Function Prototype	Description
uint8_t nvds_init(uint32_t start_addr, uint8_t sectors)	Initialize the Flash sectors used by NVDS.
uint8_t nvds_get(NvdsTag_t tag, uint16_t *p_len, uint8_t *p_buf)	Read data according to TAG IDs from NVDS.
uint8 t nvds put(NvdsTag t tag, uint16 t len, const uint8 t *p buf)	Write data to NVDS and mark the data with TAG IDs. You
	need to create a TAG ID when writing data for the first time.
uint8_t nvds_del(NvdsTag_t tag)	Remove the corresponding data of a TAG ID in NVDS.
uint16_t nvds_tag_length(NvdsTag_t tag)	Obtain the data length of a specified TAG ID.
uint8_t nvds_drv_func_replace(nvds_drv_func_t *p_nvds_drv_func)	Replace the APIs that can directly control Flash.
uint8_t nvds_func_replace(nvds_func_t *p_nvds_func)	Replace the APIs that control NVDS.
void puds rotantian size/uint8 + band day num)	Reserve space for device bonding. The space reserved
void nvds_retention_size(uint8_t bond_dev_num)	depends on the number of devices to be bonded.

#### Table 2-2 NVDS APIs

#### Dote:

For details of NVDS APIs, refer to the NVDS header file (in SDK\_Folder\components\sdk\gr55xx\_nvds.h).

## 2.5 RAM Mapping

The RAM of a GR5525 SoC is 256 KB in size with the start address of 0x2000\_0000. It consists of eight RAM blocks. Each of the first four RAM blocks is 16 KB, followed by two 32 KB blocks, and two 64 KB blocks in sequence. Each RAM block can be powered on or off by software independently.

#### 🛄 Note:

GR5525 provides RAM (start address: 0x2000\_0000) with an aliasing memory (start address: 0x0010\_0000). For more information, see Figure 2-3.

- The region (start address: 0x2000\_0000) supports bit field operations, mapping to the region starting from 0x2200\_0000.
- The region starting from 0x0010\_0000 features higher access efficiency thanks to the Cortex<sup>®</sup>-M4F architecture. Therefore, executing code in this region promotes running speed.
- In the GR5525 SDK, RW, ZI, HEAP, and STACK use the RAM region starting from 0x2000\_0000; RAM\_CODE uses the region starting from 0x0010\_0000.

The 256 KB RAM layout is shown below.

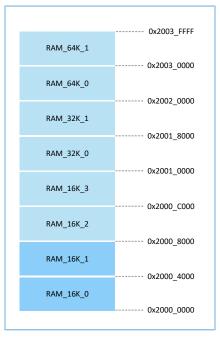


Figure 2-7 256 KB RAM layout

Running modes for applications include XIP and mirror modes. For more information about configurations, see **APP\_CODE\_RUN\_ADDR** in "Section 4.3.2.1 Configuring custom\_config.h". RAM layouts of the two modes are different.

Running Mode	Description
	It refers to Execute in Place mode. User applications are stored in on-chip Flash, and applications
XIP mode	use the same space for running and loading. When the system is powered on, it fetches and
	executes commands from Flash directly through the Cache Controller.
	In mirror mode, user applications are stored in on-chip Flash, and the running space for applications
Mirror mode	is defined in RAM. During application boot, applications are loaded into RAM from external Flash
	after check is completed, and the system jumps to RAM for operation.

#### **Note**:

Continuous access to Flash is required in XIP mode. Therefore, power consumption in this mode is a little higher than that in mirror mode.

### 2.5.1 Typical RAM Layout in XIP Mode

The typical RAM layout in XIP mode is shown below. Users can modify the layout based on product needs.

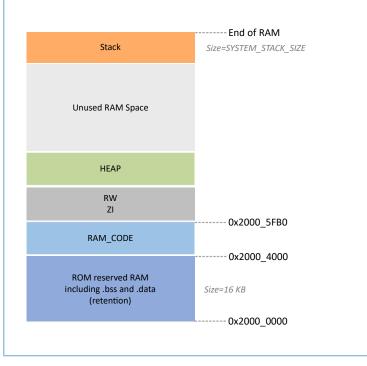


Figure 2-8 RAM layout in XIP mode

RAM\_CODE saves code executed in RAM. To boost the efficiency in execution, it is recommended to define this region in the aliasing memory (at physical address 0x0010\_0000).

The layout in XIP mode allows application firmware to be run directly in the code loading area, so that more RAM space is available for applications. During update to contents in Flash memory, XIP mode is disabled; during erase/ write operations with the smallest granularity (256 bytes for writing and 4 KB for erasing), interrupts cannot be generated.

#### 🛄 Note:

- QSPI0, QSPI1, and QSPI2 support the XIP mode, which allows mapping of address from QSPI Flash to memories, enabling direct operations on memories.
- Users can add self-defined sections as needed. Avoid modifying the default scatter file of the SDK or deleting
  part of the scatter file (such as deleting RAM\_CODE from the scatter file). For details about the scatter file, see
  "Section 4.3.2.2 Configuring Memory Layout".

### 2.5.2 Typical RAM Layout in Mirror Mode

The typical RAM layout in mirror mode is shown below. Users can modify the layout based on product needs.



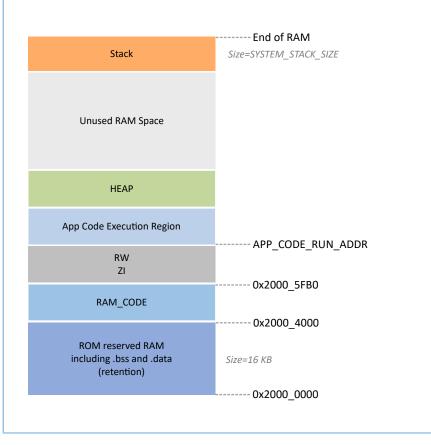


Figure 2-9 RAM layout in mirror mode

The layout in mirror mode allows application firmware to be run in RAM. The SoC enters cold boot process after power-on. The Bootloader copies application firmware from flash to the RAM segment **App Code Execution Region**. After wake-up from sleep mode, GR5525 SoC enters warm boot process. To shorten the warm boot time, the Bootloader does not redo copy of application firmware to the RAM segment **App Code Execution Region**.

The start address of the **App Code Execution Region** segment depends on APP\_CODE\_RUN\_ADDR in *custom\_config.h.* Users need to decide the value of APP\_CODE\_RUN\_ADDR based on the use of .data and .bss segments, to avoid overlapping with the .bss segment at lower address or the Call Stack segment at higher address. Users can view the layout of RAM segments from the .*map* file.

It is recommended to set APP\_CODE\_RUN\_ADDR with RAM Aliasing Memory address (from 0x0010\_0000 to 0x0013\_FFFF). Once overlapping with RAM segments happens, when a project is to be built, an error will occur and the overlapped part will be indicated, to help users quickly check and locate the overlapped part in the RAM.

### 2.5.3 RAM Power Management

Each RAM block has three power modes: Full Power, Retention Power, and Power Off.

- Full Power: The system is in active state; MCU is permitted to read from and write to RAM blocks.
- Retention Power: The system is in sleep state; data in RAM blocks does not get lost and is ready for use by the system when it switches from sleep state to active state.

# G@DiX

• Power Off: The system is in power-off state; RAM blocks will be powered off and the data in the blocks will get lost. Therefore, you need to save the data before the system is powered off.

By default, the PMU in the GR5525 enables all RAM power sources when the system starts. The GR5525 SDK also provides a complete set of RAM power management APIs. You can configure the power state of RAM blocks based on application needs.

By default, the system enables automatic RAM power management mode during boot: It automatically implements power mode control of RAM blocks according to RAM usage of applications. The configuration rules are provided as follows:

- When the system is in active state, set the unused RAM blocks to Power Off mode, and RAM blocks to be used to Full Power mode.
- When the system is in sleep state, set the unused RAM blocks to **Power Off** mode, and RAM blocks to be used to **Retention Power** mode.

Recommended RAM configurations in practice are described below:

- In Bluetooth LE applications, the first 8 KB of RAM\_16K\_0 and RAM\_16K\_1 are reserved for Bootloader and Bluetooth LE Stack only, not available for applications. When the system is in active state, RAM\_16K\_0 and RAM\_16K\_1 shall be in **Full Power** mode; when the system is in sleep state, the two RAM blocks shall be in **Retention Power** mode. Non-Bluetooth LE MCU applications can use these two RAM blocks.
- Purposes of RAM\_16K\_2 and subsequent RAM blocks are defined by applications. Generally, user data and the code segments to be executed in RAM are defined in continuous segments starting from RAM\_16K\_2; the top of function call stacks is defined in upper address part of RAM. The power mode of these RAM blocks can be enabled, or be controlled by applications.

#### 🛄 Note:

- An MCU access is permitted only when a RAM block is in **Full Power** mode.
- Details about RAM power management APIs are in SDK\_Folder\components\sdk\platform\_sdk.h.

## 2.6 SDK Directory Structure

The folder directory structure of GR5525 SDK is shown as follows.

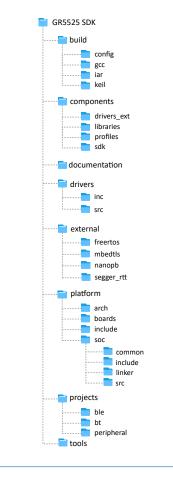


Figure 2-10 GR5525 SDK directory structure

Detailed description of folders in the GR5525 SDK is shown below.

#### Table 2-4 GR5525 SDK folders

Folder	Description	
build\config	Project configuration directory that stores the <i>custom_config.h</i> template file. This file is	
Sund (coning	used to configure projects and parameters.	
build\gcc	GCC tools	
build\keil	Keil MDK tools	
build\iar	IAR tools	
components\drivers_ext	Drivers of third-party components on the development board	
components\libraries	Libraries provided in the GR5525 SDK	
	Source files of GATT Services/Service Clients implementation examples provided in the	
components\profiles	GR5525 SDK	
components\sdk	API header files provided in the GR5525 SDK	
documentation	GR5525 API Reference Manual	

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Folder	Description	
drivers\inc	Driver API header files which are easy to use for application developers	
drivers\src	Driver API source code which is easy to use for application developers	
external\freertos	Source code of FreeRTOS (a third-party program)	
external\mbedtls	Source code of Mbed TLS (a third-party program)	
external\nanopb	Source code of Nanopb (a third-party program)	
external\segger_rtt	Source code of SEGGER RTT (a third-party program)	
platform\arch	Toolchain files of CMSIS	
platform\boards	Source files for initializing GR5525 Starter Kit Board. The files are used for initializing basic peripherals at board level.	
platform\include	Common header files related to platform	
platform\soc\common	Public source files compatible to GR5525 SoCs. The files include <i>gr_interrupt.c</i> , <i>gr_platform.c</i> , and <i>gr_system.c</i> .	
platform\soc\linker	Symbol table files and library files for the linker	
platform\soc\include	Common header files closely related to underlying driver configurations such as registers and clock configurations	
platform\soc\src	<i>gr_soc.c</i> which is about initialization processes closely related to SoC implementation. The processes include initializing Flash and NVDS, configuring crystal, and calibrating PMU.	
projects\ble	Bluetooth LE application project examples, such as Heart Rate Sensor and Proximity Reporter	
projects\bt	BT example project	
projects\peripheral	Peripheral project examples of a GR5525 SoC	
tools	GR5525 development and debugging tools	

## GODiX

## 3 Bootloader

The GR5525 supports two firmware running modes: XIP and mirror. When the system is powered on, the Bootloader first reads the system boot configuration information from SCA, then performs application firmware integrity check and initialization configuration accordingly, and finally jumps to the code running space to run firmware. The boot procedures may vary in different running modes.

- In XIP mode, the Bootloader first initializes Cache and XIP controllers after finishing application firmware check, and then jumps to the code run address in Flash to run code.
- In mirror mode, after finishing application firmware check, the Bootloader loads the firmware in Flash to corresponding RAM running space based on system configurations, and jumps to and runs the firmware in RAM.

Boot start **Reset Handler** Initialize Flash. Read boot information and check the integrity of Application Image. Is Application Yes Yes Copy Application Image to In mirror mode? Image integral? RAM from Flash. No No Initialize instruction cache. Start DFU service. Jump\_to\_app(start\_addr)

The application boot procedures of the GR5525 SDK are shown as follows.

Figure 3-1 Application boot procedures of the GR5525 SDK

- When the device is powered on, CPU jumps to 0x0000\_0000 to extract the extended stack pointer (ESP) of C-Stack and assigns the value to the main stack pointer (MSP). Then, the program counter (PC) jumps to 0x0000\_004, and executes Reset\_Handler in ROM to enter the Bootloader.
- 2. Bootloader initializes Flash.

3. Bootloader reads boot information from SCA in Flash and checks application firmware integrity.

#### Note:

GR5525 supports encrypting and signing application firmware in security mode.

- Security mode: If the security mode is enabled, the Bootloader reads boot information from SCA and performs
  HMAC check; after the check succeeds, the Bootloader decrypts SCA boot information and then implements the
  signature verification process in the secure boot process, to guarantee firmware integrity and prevent tampering
  or disguise; if signature verification succeeds, the automatic decryption functionality is enabled.
- Non-security mode: If the security mode is not enabled, the Bootloader performs cyclic redundancy check (CRC) on application firmware based on SCA boot information.
- 4. If the integrity check fails, the Bootloader starts the Bluetooth LE DFU service.
- 5. If the integrity check succeeds, the Bootloader checks the running mode.
  - In XIP mode, the Bootloader jumps to the application firmware in Flash to start implementation after XIP configuration is completed.
  - In mirror mode, the Bootloader copies the application firmware in Flash to a specified segment in RAM, and then runs the application firmware in RAM.

## 4 Development and Debugging with GR5525 SDK in Keil

This chapter introduces how to build, compile, download, and debug Bluetooth LE applications with the GR5525 SDK in Keil.

## 4.1 Installing Keil MDK

Keil MDK-ARM IDE (Keil) is an Integrated Development Environment (IDE) provided by Arm<sup>®</sup> for Cortex<sup>®</sup> and Arm devices. You can download and install the Keil installation package from the Keil official website: <u>https://www.keil.com/demo/eval/arm.htm</u>. For the GR5525 SDK, Keil V5.20 or a later version shall be installed.

#### **Note**:

For more information about how to use Keil MDK-ARM IDE, refer to online manuals provided by ARM<sup>®</sup>: <u>https://</u>www.keil.com/support/man\_arm.htm.

#### The main interface of Keil is as shown below.

	- 0	×
Brog_ @tool Office, Queen.		
Build Output		•
		~
		710

Figure 4-1 Keil interface

Frequently used function buttons of Keil are listed below:

#### Table 4-1 Frequently used function buttons of Keil

Button	Description
×	Options for Target
Q	Start/Stop Debug Session
LOND	Download



Button	Description
	Build

## 4.2 Installing GR5525 SDK

The GR5525 SDK is in a .zip file. You can access the details after extracting the file.

#### **Note**:

- SDK\_Folder is the root directory of GR5525 SDK.
- Keil\_Folder is the root directory of Keil.

## 4.3 Building a Bluetooth LE Application

This section introduces how to quickly build a custom Bluetooth LE application with Keil and GR5525 SDK.

### 4.3.1 Preparing ble\_app\_example

This section elaborates on how to create a project based on the template project provided in the GR5525 SDK.

Open SDK\_Folder\projects\ble\ble\_peripheral\, copy ble\_app\_template to the current directory, and rename it as ble\_app\_example. Change the base name of *.uvoptx* and *.uvprojx* files in ble\_app\_example\Keil\_ 5 to ble\_app\_example.

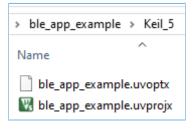


Figure 4-2 ble\_app\_example folder

Double-click *ble\_app\_example.uvprojx* to open the project example in Keil. Click *s*, and the **Options for Target 'GRxx\_Soc'** window opens. Choose the **Output** tab, and type **ble\_app\_example** in the **Name of Executable** field, to name the output file as **ble\_app\_example**.



🕎 Options for Target 'GRxx_Soc'	×
Device Target Output Listing User C/C++ Asm Linker Debug Utilities	
Select Folder for Objects Name of Executable: ble_app_example	
✓ Debug Information	
✓ Create HEX File	
✓ Browse Information	
C Create Library: .\Objects\ble_app_example.lib	
OK Cancel Defaults Help	

Figure 4-3 Modifications to Name of Executable

All groups of the ble\_app\_example project are available in the **Project** window of Keil.

🖃 🍄 Project: ble_app_example
🖨 💭 GRxx_Soc
🕀 🧰 gr_startup
🕀 🧰 gr_arch
🕀 🧰 gr_soc
🕀 🧰 gr_board
🕀 🧰 gr_stack_lib
🕀 🧰 gr_app_drivers
🗉 🛅 gr_libraries
🕀 🛄 gr_profiles
🗈 🛄 external
🕀 🧰 user_platform
🗄 들 user_app

Figure 4-4 ble\_app\_example groups

Groups of the ble\_app\_example project are mainly in two categories: SDK groups and User groups.

SDK groups

The SDK groups include gr\_startup, gr\_arch, gr\_soc, gr\_board, gr\_stack\_lib, gr\_app\_drivers, gr\_libraries, gr\_profiles, and external.

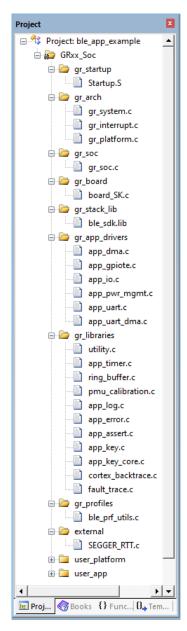


Figure 4-5 SDK groups

Source files in the SDK groups are not required to be modified. Group descriptions are provided below:

Table 4-2 SDK groups

SDK Group Name	Description	
gr_startup	System boot file	
gr_arch	Initialization configuration files and system interrupt API implementation files for System Core and PMU	
	gr_soc.c which is used for initializing and calibrating modules such as Clock, PMU, and Vector before	
gr_soc	entering the main() function	
gr_board	Board-level description file which is used for implementing components such as log, key, and LED	



SDK Group Name	Description
gr_stack_lib	GR5525 SDK .lib file
gr_app_drivers	Driver API source files which are easy to use for application developers. You can add related APP drivers on demand.
gr_libraries	Open source files of common assistant software modules and peripheral drivers provided in the SDK
gr_profiles	Source files of GATT Services/Service Clients. You can add necessary GATT source files for projects on demand.
external	Source files for third-party programs, such as FreeRTOS and SEGGER RTT. You can add third-party programs on demand.

#### • User groups

User groups include user\_platform and user\_app.

Project 🛛 📮 🗵
🖃 🍄 Project: ble_app_example
🖨 ᇶ GRxx_Soc
🖶 🛅 gr_startup
🕀 🛅 gr_arch
🕀 🛅 gr_soc
🕀 🛅 gr_board
🕀 🛅 gr_stack_lib
🗈 🛅 gr_app_drivers
🕀 🛅 gr_libraries
🕀 🛅 gr_profiles
🗈 🛅 external
🖃 🗁 user_platform
user_periph_setup.c
🖻 🗁 user_app
main.c
user_app.c
custom_config.h

Figure 4-6 user\_groups

Functionalities for source files in User groups need to be implemented by developers. Group descriptions are provided below:

Table 4-3	User	groups
-----------	------	--------

User Group Name	Description	
user_platform	Software and hardware resource setting and application initialization; you need to execute	
	corresponding APIs on demand.	



User Group Name	Description
	main() function entries and other source files created by developers, which are used to configure
	runtime parameters of Bluetooth LE Stack and execute event handlers of GATT Services/Service
	Clients

## 4.3.2 Configuring a Project

You should configure corresponding project options according to product characteristics, including NVDS, code running mode, memory layout, After Build, and other configuration items.

### 4.3.2.1 Configuring custom\_config.h

*custom\_config.h* is used to configure parameters of application projects. Developers can directly modify the configurations in the file or configure parameters in the **Configuration Wizard** interface of Keil.

#### 🛄 Note:

*custom\_config.h* of each application example project is in Src\config under the project directory.

• Modify the configurations in *custom\_config.h*.

GR5525 SDK provides a template configuration file *custom\_config.h* (in SDK\_Folder\build\config\cust om\_config.h). You can directly modify the template file to configure parameters for application projects.

Macro	Description
SOC_GR5525	Define the SoC version number.
SYS_FAULT_TRACE_ENABLE	<ul> <li>Enable/Disable trace info printing.</li> <li>If printing is enabled, the trace info is printed when a HardFault occurs.</li> <li>0: Disable</li> <li>1: Enable</li> </ul>
ENABLE_BACKTRACE_FEA	Enable/Disable the stack backtrace functionality. <ul> <li>0: Disable</li> <li>1: Enable</li> </ul>
APP_DRIVER_USE_ENABLE	<ul> <li>Enable/Disable the APP Drivers module.</li> <li>0: Disable</li> <li>1: Enable</li> </ul>
APP_LOG_ENABLE	Enable/Disable the APP LOG module. <ul> <li>0: Disable</li> <li>1: Enable</li> </ul>
APP_LOG_STORE_ENABLE	Enable/Disable the APP LOG STORE module.

Table 4-4 Parameters in *custom\_config.h* 



Macro	Description
	• 0: Disable
	• 1: Enable
	Enable/Disable DTM test.
DTM_TEST_ENABLE	• 0: Disable
	• 1: Enable
	Enable/Disable PMU calibration. When PMU calibration is enabled, the system monitors
	temperature and voltage automatically with adaptive adjustment.
	• 0: Disable
PMU_CALIBRATION_ENABLE	• 1: Enable
	Note:
	PMU calibration shall be enabled in high/low temperature scenarios.
	Start address of NVDS in Flash.
	By default, this macro is commented out in <i>cutom_config.h.</i> If you need to reconfigure
	the NVDS address, enable the macro and set the address as needed (4-KB alignment is
NVDS_START_ADDR	compulsory).
	Note:
	The start address cannot be set in used areas in the memory (such as SCA and User App).
NVDS_NUM_SECTOR	Number of Flash sectors for NVDS
	Size of Call Stack required by applications. The default value is 32 KB.
	You can set the value as needed. Please note that the value shall not be less than 6 KB.
SYSTEM_STACK_SIZE	Note:
	After compilation of ble_app_example, the Maximum Stack Usage is provided in Keil_5\0
	bjects\ble_app_example.htm for reference.
	Size of Heap required by applications. The default value is 16 KB.
SYSTEM_HEAP_SIZE	You can set the value as needed.
	Start address of the application storage area
APP_CODE_LOAD_ADDR*	Note:
	This address shall be within the Flash address range.
	Start address of the application running space
APP_CODE_RUN_ADDR*	If the value is the same as APP_CODE_LOAD_ADDR, applications run in XIP mode.
	If the value is within the RAM address range, applications run in mirror mode.
	Set the system clock frequency.
SYSTEM_CLOCK*	• 0:96 MHz
	• 1: 64 MHz

cro D	escription
0	2: 16 MHz (XO)
o	3: 48 MHz
٥	4: 24 MHz
٥	5: 16 MHz
0	6: 32 MHz (PLL)
E	nable/Disable the OSC inside an SoC as the Bluetooth LE low-frequency sleep clock. If the
	SC clock is enabled, CFG_LF_ACCURACY_PPM will be set to 500 ppm by force.
_LPCLK_INTERNAL_EN	0: Disable
٥	1: Enable
	luetooth LE low-frequency sleep clock accuracy. The value shall range from 1 to 500 (unit:
LF_ACCURACY_PPM p	pm).
Si	et 1-second delay (during SoC boot before implementing the second half Bootloader).
DT_LONG_TIME*	0: No delay
0	1: Delay for 1 second.
D	etermine whether to check the image during cold boot in XIP mode.
DT_CHECK_IMAGE 。	0: Do not check.
0	1: Check.
E	nable/Disable LDO 3.3 V.
LDO_USE_3P3_V	0: Disable
0	1: Enable
C	onfigure the algorithm security level.
URITY_CFG_VAL	0: Level 1
0	1: Level 2
	ersion of the SoC that the firmware runs on
U	lse Bluetooth LE Controller only or not.
_CONTROLLER_ONLY 。	0: Use Bluetooth LE Controller and Host.
0	1: Use Bluetooth LE Controller only.
N	Aximum number of GATT Profiles/Services supported by applications. You can set the value
_MAX_PRFS	n demand. A larger value means occupying more RAM space.
_MAX_BOND_DEVS	Naximum number of devices that can be bonded to applications; max.: 4
N	Naximum number of devices that can be connected to applications; the number shall be
_MAX_CONNECTIONS n	o greater than 10. You can set the value based on needs. A larger value means more RAM
s	pace to be occupied by Bluetooth LE Stack Heaps. The size of Bluetooth LE Stack Heaps is

• 1: Yes         CFG_MUL_LINK_WITH_SAME_DEV       Support multi-link functionality for a single device or not.         • 0: N0       • 1: Yes         CFG_BT_BREDR       Support generating Bluetooth Classic link keys through the LE link or not.         • 0: N0       • 1: Yes         CFG_CAR_KEY_SUPPORT       • 0: N0         • 1: Yes       Support car key applications or not.         CFG_CAR_KEY_SUPPORT       • 0: N0         • 1: Yes       Support master role or not.         CFG_MASTER_SUPPORT       • 0: N0         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: N0         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: N0         • 1: Yes       Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: N0         • 1: Yes       Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: N0         • 1: Yes       Support secure pairing or not.         CFG_SC_PAIR_SUPPORT       • 0: N0         • 1: Yes       Support secure pairing or not.         CFG_SC_PAIR_SUPPORT       • 0: N0	Macro	Description
PNV_HEAP_SIZE         ATT_DB_HEAP_SIZE         ATT_DB_HEAP_SIZE         KE_MSG_HEAP_SIZE         NON_RET_HEAP_SIZE         NON_RET_HEAP_SIZE         NON_RET_HEAP_SIZE         NON_RET_HEAP_SIZE         ANDYS         Maximum number of Bluetooth LE legacy advertising and extended advertising supported by applications         CFG_MAX_SCAN       Support scanning or not.         CFG_MUL_LINK_WITH_SAME_DEV       Support multi-link functionality for a single device or not.         CFG_MUL_LINK_WITH_SAME_DEV       0: No         a 1: Yes       Support generating Bluetooth Classic link keys through the LE link or not.         CFG_BT_BREDR       0: No         a 1: Yes       Support car key applications or not.         CFG_CAR_KEY_SUPPORT       0: No         a 1: Yes       Support master role or not.         CFG_MASTER_SUPPORT       0: No         a 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       0: No         a 1: Yes       Support slave role or not.         CFG_LEGACY_PAIR_SUPPORT       0: No         a 1: Yes       Support slave role or not.         CFG_LEGACY_PAIR_SUPPORT       0: No         a 1: Yes       Support slave role or not.         CFG_LEGACY_PAIR_SUPPORT		defined by the following four macros in <i>flash_scatter_config.h</i> , which cannot be changed by
• ATT_DB_HEAP_SIZE• KE_MSG_HEAP_SIZE• NON_RET_HEAP_SIZE• NON_RET_HEAP_SIZECFG_MAX_ADVSMaximum number of Bluetooth LE legacy advertising and extended advertising supported by applicationsCFG_MAX_SCANSupport scanning or not.CFG_MUL_LINK_WITH_SAME_DEV0: No• 0: No• 1: YesCFG_BT_BREDRSupport generating Bluetooth Classic link keys through the LE link or not.CFG_GAT_KEY_SUPPORT0: No• 0: No• 1: YesCFG_MASTER_SUPPORT0: No• 1: YesCFG_SLAVE_SUPPORT0: No• 1: YesCFG_LEGACY_PAIR_SUPPORT0: No• 1: YesCFG_SC_PAIR_SUPPORT0: No• 1: YesCFG_SC_PAIR_SUPPORT0: No• 1: YesCFG_LEGACY_PAIR_SUPPORT0: No• 1: YesCFG_SC_PAIR_SUPPORT0: No• 1: YesCFG_SC_PAIR_SUPPORT0: No• 1: YesCFG_SC_PAIR_SUPPORT0: No• 1: Yes <td< td=""><td></td><td>developers.</td></td<>		developers.
CFG_MAX_ADVSMaximum number of Bluetooth LE legacy advertising and extended advertising supported by applicationsCFG_MAX_SCANSupport scanning or not.CFG_MAX_SCAN0: No - 1: YesCFG_MUL_LINK_WITH_SAME_DEVSupport multi-link functionality for a single device or not.CFG_MUL_LINK_WITH_SAME_DEV0: No - 1: YesCFG_BT_BREDRSupport generating Bluetooth Classic link keys through the LE link or not.CFG_GAR_KEY_SUPPORT0: No - 1: YesCFG_MASTER_SUPPORTSupport car key applications or not.CFG_SLAVE_SUPPORT0: No - 1: YesCFG_SLAVE_SUPPORTSupport laster role or not.CFG_SLAVE_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORTSupport laster role or not.CFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORTSupport laster role or not.CFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_SLAVE_SUPPORT0: No - 1: Y		• ENV_HEAP_SIZE
NON_RET_HEAP_SIZECFG_MAX_ADVSMaximum number of Bluetooth LE legacy advertising and extended advertising supported by applicationsCFG_MAX_SCANSupport scanning or not.CFG_MAX_SCAN0: No - 1: YesCFG_MUL_LINK_WITH_SAME_DEVSupport multi-link functionality for a single device or not.CFG_MUL_LINK_WITH_SAME_DEV0: No - 1: YesCFG_BT_BREDRSupport generating Bluetooth Classic link keys through the LE link or not.CFG_GCAR_KEY_SUPPORT0: No - 1: YesCFG_CAR_KEY_SUPPORT0: No - 1: YesCFG_MASTER_SUPPORTSupport car key applications or not.CFG_SLAVE_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORTSupport slave role or not.CFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORTSupport legacy pairing or not.CFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_SLAVE_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_SLAVE_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_LEGACY_PAIR_SUPPORT0: No - 1: YesCFG_SC_PAIR_SUPPORT0: No - 1: YesCFG_SC_PAIR_SUPPORT <td< td=""><td></td><td>• ATT_DB_HEAP_SIZE</td></td<>		• ATT_DB_HEAP_SIZE
CFG_MAX_ADVS       Maximum number of Bluetooth LE legacy advertising and extended advertising supported by applications         CFG_MAX_SCAN       Support scanning or not.         CFG_MAX_SCAN       • 0: No         • 1: Yes       Support multi-link functionality for a single device or not.         CFG_MUL_LINK_WITH_SAME_DEV       • 0: No         • 1: Yes       Support generating Bluetooth Classic link keys through the LE link or not.         CFG_BT_BREDR       • 0: No         • 1: Yes       Support agenerating Bluetooth Classic link keys through the LE link or not.         CFG_CAR_KEY_SUPPORT       • 0: No         • 1: Yes       Support car key applications or not.         CFG_CAR_KEY_SUPPORT       • 0: No         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes       Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes       Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes       Support legacy pairing or not.         CFG_SLEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes       Support secure pairing or not.      <		• KE_MSG_HEAP_SIZE
CFG_MAX_ADVSapplicationsCFG_MAX_SCANSupport scanning or not.CFG_MAX_SCAN• 0: No• 1: YesSupport multi-link functionality for a single device or not.CFG_MUL_UNK_WITH_SAME_DEV• 0: No• 1: YesSupport generating Bluetooth Classic link keys through the LE link or not.CFG_BT_BREDR• 0: No• 1: Yes• 0: No• 1: Yes• 1: YesCFG_CAR_KEY_SUPPORT• 0: No• 1: Yes• 1: YesCFG_LEGACY_PAIR_SUPPORT• 0: No• 1: Yes• 1: YesCFG_SC_PAIR_SUPPORT• 0: No• 1: Yes• 1: YesCFG_SC_PAIR_SUPPORT• 0: No• 0: No• 1: Yes• 0: No• 1: Yes<		• NON_RET_HEAP_SIZE
applicationsEFG_MAX_SCANSupport scanning or not.> 0: No> 1: YesCFG_MUL_LINK_WITH_SAME_DEVSupport multi-link functionality for a single device or not.> 0: No> 1: YesCFG_BT_BREDRSupport generating Bluetooth Classic link keys through the LE link or not.CFG_CAR_KEY_SUPPORT0: No> 1: YesCFG_CAR_KEY_SUPPORT0: No> 1: YesCFG_MASTER_SUPPORT0: No> 1: YesCFG_EG_SLAVE_SUPPORT0: No> 1: YesCFG_LEGACY_PAIR_SUPPORT0: No> 1: YesCFG_LEGACY_PAIR_SUPPORT0: No> 0: No> 1: YesCFG_SLAVE_SUPPORT0: No> 0: No> 1: YesCFG_LEGACY_PAIR_SUPPORT0: No> 0: No> 1: YesCFG_LEGACY_PAIR_SUPPORT0: No> 0: No> 1: YesCFG_SLAVE_SUPPORT0: No> 0: No> 1: YesCFG_LEGACY_PAIR_SUPPORT> 0: No> 0: No <td>CEG MAY ADVS</td> <td>Maximum number of Bluetooth LE legacy advertising and extended advertising supported by</td>	CEG MAY ADVS	Maximum number of Bluetooth LE legacy advertising and extended advertising supported by
CFG_MAX_SCAN       • 0: No         < 1: Yes	CFG_MAX_ADVS	applications
• 1: Yes         CFG_MUL_LINK_WITH_SAME_DEV       Support multi-link functionality for a single device or not.         • 0: No       • 1: Yes         CFG_BT_BREDR       Support generating Bluetooth Classic link keys through the LE link or not.         CFG_GTAR_KEY_SUPPORT       • 0: No         • 1: Yes       Support car key applications or not.         CFG_CAR_KEY_SUPPORT       • 0: No         • 1: Yes       Support master role or not.         CFG_MASTER_SUPPORT       • 0: No         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes       Support slave role or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes       Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes       Support secure pairing or not.         CFG_SC_PAIR_SUPPORT       • 0: No         • 0: No       • 1: Yes         Support secure pairing or not.       • 0: No         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       • 0: No		Support scanning or not.
Support multi-link functionality for a single device or not.         CFG_MUL_LINK_WITH_SAME_DEV <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_BT_BREDR       Support generating Bluetooth Classic link keys through the LE link or not.         CFG_BT_BREDR <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_CAR_KEY_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_MASTER_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_SLAVE_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_SLAVE_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_LEGACY_PAIR_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_LEGACY_PAIR_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_SLAVE_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_LEGACY_PAIR_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> <li>Support secure pairing or not.</li> <li>0: No</li> <li>1: Yes</li> <li>Support secure pairing or not.</li> </ul>	CFG_MAX_SCAN	• 0: No
CFG_MUL_LINK_WITH_SAME_DEV       • 0: No         • 1: Yes         Support generating Bluetooth Classic link keys through the LE link or not.         CFG_BT_BREDR       • 0: No         • 1: Yes         Support car key applications or not.         CFG_CAR_KEY_SUPPORT       • 0: No         • 1: Yes         Support master role or not.         CFG_MASTER_SUPPORT       • 0: No         • 1: Yes         Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes         Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes         Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes         Support secure pairing or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes         Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 1: Yes         Support secure pairing or not.         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       • 0: No		• 1: Yes
• 1: Yes         CFG_BT_BREDR       Support generating Bluetooth Classic link keys through the LE link or not.         • 0: No       • 1: Yes         CFG_CAR_KEY_SUPPORT       Support car key applications or not.         • 0: No       • 1: Yes         CFG_CAR_KEY_SUPPORT       • 0: No         • 1: Yes       • 0: No         • 0: No       • 0: No         • 0		Support multi-link functionality for a single device or not.
Support generating Bluetooth Classic link keys through the LE link or not.CFG_BT_BREDR0: No1: YesSupport car key applications or not.CFG_CAR_KEY_SUPPORT0: No0: No1: YesCFG_MASTER_SUPPORT0: No0: No1: YesCFG_SLAVE_SUPPORT0: No0: No1: YesCFG_SLAVE_SUPPORT0: No0: No1: YesCFG_LEGACY_PAIR_SUPPORT0: No1: Yes1: YesCFG_LEGACY_PAIR_SUPPORT0: No1: Yes1: YesCFG_LEGACY_PAIR_SUPPORT0: No0: No1: YesCFG_LEGACY_PAIR_SUPPORT0: No0: No1: YesCFG_LEGACY_PAIR_SUPPORT0: No0: No1: YesCFG_LEGACY_PAIR_SUPPORT0: No0: No1: YesCFG_SC_PAIR_SUPPORT0: No	CFG_MUL_LINK_WITH_SAME_DEV	• 0: No
CFG_BT_BREDR       • 0: No         • 1: Yes         Support car key applications or not.         CFG_CAR_KEY_SUPPORT       • 0: No         • 1: Yes         CFG_MASTER_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SLAVE_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SLAVE_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes       • 0: No         • 0: No       • 0: No         • 0: NO       •		• 1: Yes
• 1: Yes         Support car key applications or not.         CFG_CAR_KEY_SUPPORT         • 0: No         • 1: Yes         Support master role or not.         • 0: No         • 1: Yes         Support slave role or not.         • 1: Yes         Support slave role or not.         • 0: No         • 1: Yes         Support slave role or not.         • 0: No         • 1: Yes         Support slave role or not.         • 0: No         • 1: Yes         Support slave role or not.         • 0: No         • 1: Yes         Support legacy pairing or not.         CFG_LEGACY_PAIR_SUPPORT         • 0: No         • 1: Yes         Support secure pairing or not.         CFG_SLAWE_SUPPORT         • 0: No         • 1: Yes         Support secure pairing or not.         • 0: No         • 1: Yes         Support secure pairing or not.         • 0: No		Support generating Bluetooth Classic link keys through the LE link or not.
CFG_CAR_KEY_SUPPORT       Support car key applications or not.         · 0: No       · 1: Yes         CFG_MASTER_SUPPORT       Support master role or not.         · 0: No       · 1: Yes         CFG_SLAVE_SUPPORT       Support slave role or not.         · 0: No       · 1: Yes         CFG_LEGACY_PAIR_SUPPORT       Support legacy pairing or not.         · 0: No       · 1: Yes         CFG_LEGACY_PAIR_SUPPORT       Support slave role or not.         · 0: No       · 1: Yes         Support legacy pairing or not.       · 0: No         · 1: Yes       · 0: No         · 1: Yes       · 0: No         · 0: No       · 0: No	CFG_BT_BREDR	• 0: No
CFG_CAR_KEY_SUPPORT• 0: No• 1: YesCFG_MASTER_SUPPORTSupport master role or not.• 0: No• 1: YesCFG_SLAVE_SUPPORT• 0: No• 0: No• 1: YesCFG_LEGACY_PAIR_SUPPORTSupport legacy pairing or not.CFG_SLAVE_SUPPORT• 0: No• 0: No• 1: YesCFG_LEGACY_PAIR_SUPPORT• 0: No• 0: No		• 1: Yes
• 1: Yes         CFG_MASTER_SUPPORT       Support master role or not.         • 0: No       • 1: Yes         CFG_SLAVE_SUPPORT       Support slave role or not.         • 0: No       • 1: Yes         • 0: No       • 1: Yes         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_LEGACY_PAIR_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       • 0: No         • 0: No       • 0: No         • 0: No       • 0: No         • 0: No       • 0: No		Support car key applications or not.
CFG_MASTER_SUPPORT       Support master role or not.         0       0: No         0       1: Yes         CFG_SLAVE_SUPPORT       Support slave role or not.         0       0: No         0       1: Yes         0       1: Yes         Support legacy pairing or not.         0: No       0: No         1: Yes       Support slave role or not.         CFG_LEGACY_PAIR_SUPPORT       0: No         1: Yes       1: Yes         CFG_SC_PAIR_SUPPORT       Support secure pairing or not.         CFG_SC_PAIR_SUPPORT       0: No	CFG_CAR_KEY_SUPPORT	• 0: No
CFG_MASTER_SUPPORT       • 0: No         • 1: Yes       Support slave role or not.         CFG_SLAVE_SUPPORT       • 0: No         • 1: Yes       • 1: Yes         CFG_LEGACY_PAIR_SUPPORT       Support legacy pairing or not.         CFG_SC_PAIR_SUPPORT       • 0: No         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       • 0: No         • 0: No       • 0: No		• 1: Yes
• 1: Yes       CFG_SLAVE_SUPPORT     Support slave role or not.       • 0: No     • 1: Yes       CFG_LEGACY_PAIR_SUPPORT     Support legacy pairing or not.       • 0: No     • 1: Yes       CFG_SC_PAIR_SUPPORT     • 0: No       • 0: No     • 1: Yes       CFG_SC_PAIR_SUPPORT     • 0: No       • 0: No     • 0: No		Support master role or not.
CFG_SLAVE_SUPPORT       Support slave role or not.         • 0: No       • 1: Yes         CFG_LEGACY_PAIR_SUPPORT       Support legacy pairing or not.         • 0: No       • 0: No         • 1: Yes       • 0: No         • 0: No       • 0: No	CFG_MASTER_SUPPORT	• 0: No
CFG_SLAVE_SUPPORT <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_LEGACY_PAIR_SUPPORT          Support legacy pairing or not. <ul> <li>0: No</li> <li>1: Yes</li> </ul> CFG_SC_PAIR_SUPPORT          Support secure pairing or not. <ul> <li>0: No</li> <li>1: Yes</li> </ul>		• 1: Yes
• 1: Yes         CFG_LEGACY_PAIR_SUPPORT       Support legacy pairing or not.         • 0: No         • 1: Yes         CFG_SC_PAIR_SUPPORT       Support secure pairing or not.         • 0: No		Support slave role or not.
CFG_LEGACY_PAIR_SUPPORT       Support legacy pairing or not.         • 0: No       • 1: Yes         CFG_SC_PAIR_SUPPORT       Support secure pairing or not.         • 0: No       • 0: No	CFG_SLAVE_SUPPORT	• 0: No
CFG_LEGACY_PAIR_SUPPORT          • 0: No         • 1: Yes         Support secure pairing or not.         • 0: No         • 0: No		• 1: Yes
<ul> <li>• 1: Yes</li> <li>Support secure pairing or not.</li> <li>• 0: No</li> </ul>		Support legacy pairing or not.
CFG_SC_PAIR_SUPPORT       0: No	CFG_LEGACY_PAIR_SUPPORT	• 0: No
CFG_SC_PAIR_SUPPORT • 0: No		• 1: Yes
	CFG_SC_PAIR_SUPPORT	Support secure pairing or not.
		• 0: No
° 1: Yes		• 1: Yes
CFG_COC_SUPPORT Support Connection-oriented Channel (COC) or not.	CFG_COC_SUPPORT	Support Connection-oriented Channel (COC) or not.



Macro	Description
	• 0: No
	• 1: Yes
	Support GATT Server module or not.
CFG_GATTS_SUPPORT	• 0: No
	• 1: Yes
	Support GATT Client module or not.
CFG_GATTC_SUPPORT	• 0: No
	• 1: Yes
	Support connection-based AoA/AoD or not.
CFG_CONN_AOA_AOD_SUPPORT	• 0: No
	• 1: Yes
	Support connectionless AoA/AoD or not.
CFG_CONNLESS_AOA_AOD_SUPPORT	• 0: No
	• 1: Yes
	Support ranging or not.
CFG_RANGING_SUPPORT	• 0: No
	• 1: Yes

\*: Macros marked with an asterisk (\*) in the table above are used to initialize the BUILD\_IN\_APP\_INFO structure which is defined at 0x200 in the firmware and is initialized with the macros in *custom\_config.h*. When the system boots, the Bootloader reads value from 0x200 and uses it as a boot parameter.

Configure parameters in the **Configuration Wizard** interface.

Comments in *custom\_config.h* are compliant with <u>Configuration Wizard Annotations</u> of Keil, making it possible for developers to open *custom\_config.h* in Keil and configure application project parameters in the **Configuration Wizard** interface of Keil.

Custom_config.h		
Expand All Collapse All Help Show Grid		
Option	Value	
Basic configuration		
Chip version	1	
Enable system fault trace module	ENABLE	
Enable app driver module	ENABLE	
Eanble APP log module	ENABLE	
APP log port type	UART	
Eanble APP log store module	DISABLE	
Enable SK GUI module	DISABLE	
Enable DTM test support	DISABLE	
Enable BLE DFU support	ENABLE	
Enable PMU Calibration	ENABLE	
Protection priority level	0	
The Number of sectors for NVDS	1	
Call Stack Size	0x0000 3000	
Call Heap Size	0x0000 4000	
Boot info configuration		
Code load address	Flash address	
Code run address	Flash address	
System clock	96MHZ	
External clock accuracy used in the LL to compute timing	500	
Enable internal osc as low power clock	Default: Disable internal osc as low power clock	
Delay time for Boot startup	Delay 500ms	
In xip mode, check image during cold boot startup	Check image	
Code version.16bits	1	
algorithm security level	Enable algorithm level one	
*		

Figure 4-7 custom\_config.h in the Configuration Wizard interface

## 4.3.2.2 Configuring Memory Layout

In a Keil project, the memory area for the linker is defined in scatter (.sct) files. The GR5525 SDK provides an example scatter file (SDK\_Folder\platform\soc\linker\keil\flash\_scatter\_common.sct) to help developers quickly configure memory layout. The macros used by *flash\_scatter\_common.sct* are defined in *flash\_scatter\_config.h.* 

#### Note:

In Keil, \_\_attribute\_\_((section("name"))) can be used to define a function or a variable in a specific memory segment, in which **name** can be customized by developers. The scatter (*.sct*) file defines the location for customized fields. For example, to define the Zero-Initialized (ZI) data of applications in the segment named as .bss.app, you can set attribute to \_\_attribute\_\_((section(".bss.app"))).

You can follow the steps below to configure the memory layout:

- 1. Click ▲ (Options for Target) on the Keil toolbar and open the Options for Target 'GRxx\_Soc' dialog box. Select the Linker tab.
- 2. On the Scatter File bar of the Linker tab, click ... to browse and select the *flash\_scatter\_common.sct* file in SDK\_ Folder\platform\soc\linker\keil. You can also copy the scatter (.sct) file and the configuration (.h) file to the ble\_app\_example project directory and then select the scatter file.

# GODIX

### Note:

#! armcc -E -I in *flash\_scatter\_common.sct* specifies the directory of the header file on which *flash\_scatter\_common.sct* depends. A wrong path results in a linker error.

3. Click Edit... to open the .sct file, and modify corresponding code based on practical product memory layout.

Options for Target 'GRxx_Soc'		×
Device   Target   Output   Listing   User   C/C++   Asn Use Memory Layout from Target Dialog Make RW Sections Position Independent	m Linker Debug Utilities X/O Base: R/O Base: 0x0000000	
<ul> <li>Make RO Sections Position Independent</li> <li>Don't Search Standard Libraries</li> <li>Report 'might fail' Conditions as Errors</li> </ul>	R/W Base 0x00060000 disable Warnings:	
Scatter	scatter_common.sct 💽 Edit	
Misc	ymbol.txt	$\hat{}$
Linker control string -cpu Cortex-M4.fp *.o -Hibrary_type=microlib -strict -scatter "\\	\\\platform\soc\linker\keil\flash_scatter_common.sct	. ~
ОК	Cancel Defaults	Help

Figure 4-8 Configuration of scatter file

4. Click **OK** to save the settings.

## 4.3.2.3 Configuring After Build

After Build in Keil can specify the command to be executed after a project is built.

By default, After Build has been configured for the ble\_app\_template project. Therefore, ble\_app\_example, which is based on ble\_app\_template, does not require manual configuration of After Build.

If you build a project in Keil, follow the steps below to configure After Build:

- 1. Click (Options for Target) on the Keil toolbar and open the Options for Target 'GRxx\_Soc' dialog box. Select the User tab.
- From the options expanded from After Build/Rebuild, select Run #1, and type fromelf.exe --text -c --output Listings\@L.s Objects\@L.axf in the corresponding User Command field. This step helps you utilize Keil fromelf to generate a compiling file based on the selected .axf file.
- From the options expanded from After Build/Rebuild, select Run #2, and type fromelf.exe --bin --output Listings
   \@L.bin Objects\@L.axf in the corresponding User Command field. This step helps you utilize Keil fromelf to
   generate a compiling file based on the selected .axf file.
- 4. Click **OK** to save the settings.



Command Items	User Command		Stop on Exi	S
Before Compile C/C++ File				
Run #1		2	Not Specified	$\Box$
🗌 🗌 Run #2		2	Not Specified	$\Box$
Before Build/Rebuild				
Run #1		2	Not Specified	
Run #2		2	Not Specified	
After Build/Rebuild				
🔽 Run #1	fromelf.exetext -coutput Listings\@L.s Ob	_		
🔽 Run #2	fromelf.exebinoutput Listings\@L.bin Obje	2	Not Specified	
☐ Run 'After-Build' Conditionally ▼ Beep When Complete	Start Debugging			

Figure 4-9 Configuration of After Build

## 4.3.3 Adding User Code

You can modify corresponding code in ble\_app\_example on demand.

#### 4.3.3.1 Modifying the main() Function

Code of a typical *main.c* file is provided as follows:

```
/**@brief Stack global variables for Bluetooth protocol stack. */
STACK_HEAP_INIT(heaps_table);
...
int main (void)
{
    /** Initialize user peripherals. */
    app_periph_init();
    /** Initialize BLE Stack. */
    ble_stack_init(&&m_app_ble_callback, &heaps_table);
    // Main Loop
    while (1)
    {
        app_log_flush();
        pwr_mgmt_schedule();
    }
}
```

• STACK\_HEAP\_INIT(heaps\_table) defines seven global arrays as Heaps for Bluetooth LE Stack. Do not modify the definition; otherwise, Bluetooth LE Stack may not work properly. The Heap size is determined by the Bluetooth LE service volume in "Section 4.3.2.1 Configuring custom\_config.h".

app\_periph\_init() is used to initialize peripherals. In development and debugging phases,
 SYS\_SET\_BD\_ADDR in this function can be used to set a temporary Public Address; pwr\_mgmt\_mode\_set() sets the MCU operation mode (SLEEP/IDLE/ACTIVE) during automatic power management; app\_periph\_init() is implemented in user\_periph\_setup.c, and the example code is as follows.

```
/**@brief Bluetooth device address. */
static const uint8_t s_bd_addr[SYS_BD_ADDR_LEN] = {0x11, 0x11, 0x11, 0x11, 0x11, 0x11;
...
void app_periph_init(void)
{
    SYS_SET_BD_ADDR(s_bd_addr);
    bsp_log_init();
    pwr_mgmt_mode_set(PMR_MGMT_IDLE_MODE);
}
```

- Add main loop code of applications to while(1) { }, for example, code to handle external input and update GUI.
- To use the APP LOG module, call app\_log\_flush() in the main loop, to ensure logs are output completely before the system enters sleep state. For more information about the APP LOG module, refer to "Section 4.6.3 Outputting Debug Logs".
- Call pwr\_mgmt\_shcedule() to implement automatic power management to reduce system power consumption.

#### 4.3.3.2 Implementing Bluetooth LE Service Logics

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Bluetooth LE service logics of applications are driven by a number of Bluetooth LE events which are defined in GR5525 SDK. Therefore, applications need to implement the corresponding event handlers in GR5525 SDK to obtain operation results or state change notifications of Bluetooth LE Stack. The event handlers are called in the interrupt context of Bluetooth LE SDK IRQ. Therefore, do not perform long-running operations in handlers, for example, blocking function call and infinite loop; otherwise, the system is blocked, causing Bluetooth LE Stack and the SDK Bluetooth LE module unable to run in a normal timing.

Bluetooth LE events fall into eight categories: Common, GAP Management, GAP Connection Control, Security Manager, L2CAP, GATT Common, GATT Server, and GATT Client. All Bluetooth LE events supported by GR5525 SDK are listed below.

Event Type	Event Name	Description	
Common	BLE COMMON EVT STACK INIT	Bluetooth LE Stack init complete	
		event	
GAP Management	BLE_GAPM_EVT_CH_MAP_SET	Channel Map Set complete event	
	BLE_GAPM_EVT_WHITELIST_SET	Whitelist Set complete event	
		Periodic Advertising List Set	
	BLE_GAPM_EVT_PER_ADV_LIST_SET	complete event	

#### Table 4-5 Bluetooth LE events



Event Type	Event Name	Description
	BLE_GAPM_EVT_PRIVACY_MODE_SET	Privacy Mode for Peer Device Set complete event
	BLE_GAPM_EVT_LEPSM_REGISTER	LEPSM Register complete event
	BLE_GAPM_EVT_LEPSM_UNREGISTER	LEPSM Unregister complete event
	BLE_GAPM_EVT_DEV_INFO_GOT	Device Info Get event
	BLE_GAPM_EVT_ADV_START	Advertising Start complete event
	BLE_GAPM_EVT_ADV_STOP	Advertising Stop complete event
	BLE_GAPM_EVT_SCAN_REQUEST	Scan Request event
	BLE_GAPM_EVT_ADV_DATA_UPDATE	Advertising Data update event
	BLE_GAPM_EVT_SCAN_START	Scan Start complete event
	BLE_GAPM_EVT_SCAN_STOP	Scan Stop complete event
	BLE_GAPM_EVT_ADV_REPORT	Advertising Report event
		Periodic Advertising
	BLE_GAPM_EVT_SYNC_ESTABLISH	Synchronization Establish event
		Periodic Advertising
	BLE_GAPM_EVT_SYNC_STOP	Synchronization Stop event
		Periodic Advertising
	BLE_GAPM_EVT_SYNC_LOST	Synchronization Lost event
	BLE_GAPM_EVT_READ_RSLV_ADDR	Read Resolvable Address event
	BLE_GAPC_EVT_PHY_UPDATED	PHY Update event
	BLE_GAPC_EVT_CONNECTED	Connected event
	BLE_GAPC_EVT_DISCONNECTED	Disconnected event
	BLE_GAPC_EVT_CONNECT_CANCEL	Connect Cancel event
	BLE_GAPC_EVT_AUTO_CONN_TIMEOUT	Auto Connect Timeout event
	BLE_GAPC_EVT_CONN_PARAM_UPDATED	Connect Parameter Updated event
	BLE_GAPC_EVT_CONN_PARAM_UPDATE_REQ	Connect Parameter Request event
GAP Connection Control	BLE_GAPC_EVT_PEER_NAME_GOT	Peer Name Get event
	BLE_GAPC_EVT_CONN_INFO_GOT	Connect Info Get event
	BLE_GAPC_EVT_PEER_INFO_GOT	Peer Info Get event
	BLE_GAPC_EVT_DATA_LENGTH_UPDATED	Data Length Updated event
	BLE_GAPC_EVT_DEV_INFO_SET	Device Info Set event
	BLE_GAPC_EVT_CONNECT_IQ_REPORT	Connection IQ Report info event
	BLE_GAPC_EVT_CONNECTLESS_IQ_REPORT	Connectionless IQ Report info event



Event Type	Event Name	Description
	BLE_GAPC_EVT_LOCAL_TX_POWER_READ	Local transmit power read
		indication info event
	BLE_GAPC_EVT_REMOTE_TX_POWER_READ	Remote transmit power read
		indication info event
	BLE GAPC EVT TX POWER CHANGE REPORT	Transmit power change reporting
		info event
	BLE_GAPC_EVT_PATH_LOSS_THRESHOLD_REPORT	Path loss threshold reporting info
		event
	BLE_GAPC_EVT_RANGING_IND	Ranging indication event
	BLE_GAPC_EVT_RANGING_SAMPLE_REPORT	Ranging sample report event
	BLE_GAPC_EVT_RANGING_CMP_IND	Ranging complete indication event
	BLE_GAPC_EVT_DFT_SUBRATE_SET	Default subrate param set complete
		event
	BLE_GAPC_EVT_SUBRATE_CHANGE_IND	Subrate change indication event
GATT Common	BLE_GATT_COMMON_EVT_MTU_EXCHANGE	MTU Exchange event
	BLE_GATT_COMMON_EVT_PRF_REGISTER	Service Register event
	BLE_GATTS_EVT_READ_REQUEST	GATTS Read Request event
	BLE_GATTS_EVT_WRITE_REQUEST	GATTS Write Request event
	BLE_GATTS_EVT_PREP_WRITE_REQUEST	GATTS Prepare Write Request event
	BLE_GATTS_EVT_NTF_IND	GATTS Notify or Indicate Complete
		event
	BLE_GATTS_EVT_CCCD_RECOVERY	GATTS CCCD Recovery event
	BLE_GATTS_EVT_MULT_NTF	GATTS Multiple Notifications event
	BLE_GATTS_EVT_ENH_READ_REQUEST	GATTS Enhanced Read Request
GATT Server		event
	BLE_GATTS_EVT_ENH_WRITE_REQUEST	GATTS Enhanced Write Request
		event
	BLE_GATTS_EVT_ENH_PREP_WRITE_REQUEST	GATTS Enhanced Prepare Write
		Request event
	BLE_GATTS_EVT_ENH_NTF_IND	GATTS Enhanced Notify or Indicate
		Complete event
	BLE_GATTS_EVT_ENH_CCCD_RECOVERY	GATTS Enhanced CCCD Recovery
		event



Event Type	Event Name	Description
	BLE_GATTS_EVT_ENH_MULT_NTF	GATTS Enhanced Multiple
		Notifications event
	BLE_GATTC_EVT_SRVC_BROWSE	GATTC Service Browse event
		GATTC Primary Service Discovery
	BLE_GATTC_EVT_PRIMARY_SRVC_DISC	event
		GATTC Include Service Discovery
	BLE_GATTC_EVT_INCLUDE_SRVC_DISC	event
		GATTC Characteristic Discovery
	BLE_GATTC_EVT_CHAR_DISC	event
		GATTC Characteristic Descriptor
	BLE_GATTC_EVT_CHAR_DESC_DISC	Discovery event
	BLE_GATTC_EVT_READ_RSP	GATTC Read Response event
	BLE_GATTC_EVT_WRITE_RSP	GATTC Write Response event
		GATTC Notify or Indicate Receive
	BLE_GATTC_EVT_NTF_IND	event
	BLE_GATTC_EVT_CACHE_UPDATE	GATTC Cache Update event
		GATTC Enhanced Service Browse
GATT Client	BLE_GATTC_EVT_ENH_SRVC_BROWSE	event
		GATTC Enhanced Primary Service
	BLE_GATTC_EVT_ENH_PRIMARY_SRVC_DISC	Discovery event
		GATTC Enhanced Include Service
	BLE_GATTC_EVT_ENH_INCLUDE_SRVC_DISC	Discovery event
		GATTC Enhanced Characteristic
	BLE_GATTC_EVT_ENH_CHAR_DISC	Discovery event
		GATTC Enhanced Characteristic
	BLE_GATTC_EVT_ENH_CHAR_DESC_DISC	Descriptor Discovery event
		GATTC Enhanced Read Response
	BLE_GATTC_EVT_ENH_READ_RSP	event
	DUE CATTO ENT SAUL MUDITE COD	GATTC Enhanced Write Response
	BLE_GATTC_EVT_ENH_WRITE_RSP	event
		GATTC Enhanced Notify or Indicate
	BLE_GATTC_EVT_ENH_NTF_IND	Receive event
	BLE_SEC_EVT_LINK_ENC_REQUEST	Link Encrypted Request event
Security Manager	BLE_SEC_EVT_LINK_ENCRYPTED	Link Encrypted event
	BLE_SEC_EVT_KEY_PRESS_NTF	Key Press event



Event Type	Event Name	Description		
	BLE_SEC_EVT_KEY_MISSING	Key Missing event		
	BLE_L2CAP_EVT_CONN_REQ	L2CAP Connect Request event		
	BLE_L2CAP_EVT_CONN_IND	L2CAP Connected Indicate event		
	BLE_L2CAP_EVT_ADD_CREDITS_IND	L2CAP Credits Add Indicate event		
	BLE_L2CAP_EVT_DISCONNECTED	L2CAP Disconnected event		
	BLE_L2CAP_EVT_SDU_RECV	L2CAP SDU Receive event		
	BLE_L2CAP_EVT_SDU_SEND	L2CAP SDU Send event		
	BLE_L2CAP_EVT_ADD_CREDITS_CPLT	L2CAP Credits Add Completed event		
L2CAP	BLE L2CAP EVT ENH CONN REQ	L2CAP Enhanced Connect Request		
		L2CAP Enhanced Connect Request event		
	BLE L2CAP EVT ENH CONN IND	L2CAP Enhanced Connected		
		Indicate event		
	BLE_L2CAP_EVT_ENH_RECONFIG_CPLT	L2CAP Enhanced Reconfig		
		Completed event		
	BLE L2CAP EVT ENH RECONFIG IND	L2CAP Enhanced Reconfig Indicate		
		event		

You need to implement necessary Bluetooth LE event handlers according to functional requirements of your products. For example, if a product does not support Security Manager, you do not need to implement corresponding events; if the product supports GATT Server only, you do not need to implement the events corresponding to GATT Client. Only those event handlers required for products are to be implemented.

### **△**Tip:

For details about the usage of Bluetooth LE APIs and event APIs, refer to the source code of Bluetooth LE examples in SDK\_Folder\documentation\GR5525\_API\_Reference and SDK\_Folder\projects\ble.

## 4.3.3.3 Scheduling BLE\_Stack\_IRQ, BLE\_SDK\_IRQ, and Applications

Bluetooth LE Stack is the core to implement Bluetooth LE protocols. It can directly operate the Bluetooth 5.3 Core (refer to "Section 2.2 Software Architecture"). Therefore, BLE\_Stack\_IRQ has the second-highest priority after SVCall IRQ, which ensures that Bluetooth LE Stack runs strictly in a timing specified in *Bluetooth Core Spec*.

A state change of Bluetooth LE Stack triggers the BLE\_SDK\_IRQ interrupt with lower priority. In this interrupt handler, the Bluetooth LE event handlers (to be executed in applications) are called to send state change notifications of Bluetooth LE Stack and related service data to applications. Avoid time-consuming operations when using these event handlers. Perform such operations in the main loop or in user-level threads instead. You can use the module in SDK\_Folder\components\libraries\app\_queue, or your own application framework, to transfer events from Bluetooth LE event handlers to the main loop.



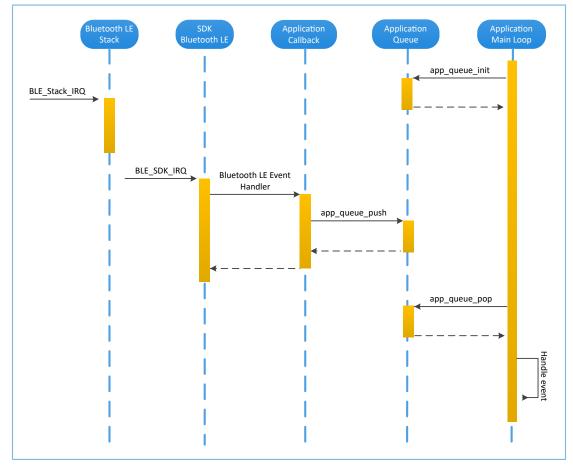


Figure 4-10 System schedule (without OS)

# 4.4 Generating Firmware

After building a Bluetooth LE application, you can directly click 🖾 (Build) on the Keil toolbar to build a project. After project compilation is completed, two firmware files (in .bin and .hex formats) are created in Keil\_5\Listings and Keil\_5\Objects respectively in the project directory.

Table 4-6	Firmware files	generated
-----------	----------------	-----------

Name	Description
ble_app_example.bin	Binary application firmware, can be downloaded to Flash through GProgrammer for running
ble_app_example.hex	Binary application firmware, can be downloaded to Flash through Keil or GProgrammer for running

### **Tip**:

Both the two types of firmware can be downloaded to Flash through GProgrammer for running. Refer to *GProgrammer User Manual* for details.

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# 4.5 Downloading .hex Files to Flash

After a firmware file is are generated, you need to download the file to Flash. Specific steps are provided below:

- 1. Configure Keil Flash programming algorithm.
  - (1). Copy SDK\_Folder\build\binaries\download\_algorithm\Keil\GR5xxx\_16MB\_Flash.F
    LM to Keil\_Folder\ARM\Flash.
  - (2). Click (Options for Target) on the Keil toolbar, open the Options for Target 'GRxx\_Soc' dialog box, and select the Debug tab. Click Settings on the right side of Use: J-LINK/J-TRACE Cortex.

Options for Target 'GRxx_Soc'	×		
Device   Target   Output   Listing   User   C/C++   Asm   C Use Simulator with restrictions Settings Limit Speed to Real-Time	Linker Debug Utilities		
Load Application at Startup     Run to main() Initialization File:      Edit	Load Application at Startup Run to main() Initialization File:		
Restore Debug Session Settings         Image: Breakpoints       Image: Toolbox         Image: Breakpoints       Image:	Restore Debug Session Settings         Image: Breakpoints       Image: Toolbox         Image: Watch Windows         Image: Watch Watch Windows         Image: Watch		
Dialog DLL: Parameter: DCM.DLL PCM4 Way f outdated Executable is loaded	Dialog DLL:         Parameter:           TCM.DLL         pCM4           Warn if outdated Executable is loaded		
Manage Component Viewer Description Files			
OK Car	ncel Defaults Help		

Figure 4-11 Debug tab

(3). In the **Cortex JLink/JTrace Target Driver Setup** window, select **Flash Download**. In the **Download Function** pane, you can set the erase type and check optional items: **Program, Verify**, and **Reset and Run**. Default configurations of Keil are shown below:



Cortex JLink/JTrace Targ	et Driver Setup				×
					ŕ
Debug Trace Flash I	Download				
C Do r	e Full Chip I⊽ Program e Sectors I⊽ Verify not Erase I⊽ Reset and	Sta	for Algorithm	Size: 0xF000	
Programming Algori		(			
Description	Device Size	Device Type	Address Rang	e	_
		Sta	rt:	Size:	
	Ad	d Remo	ove		
			确定	取消	应用( <u>A</u> )

Figure 4-12 Default configurations in the Download Function pane

(4). Click Add to add *GR5xxx\_16MB\_Flash.FLM* (in SDK\_Folder\build\keil\) to **Programming** Algorithm.



ug   Trace	Flash Download	'I			
LOAD	Function C Erase Full Chip Erase Sectors Do not Erase	Verify	Sta	for Algorithm	: 0xF000
-	ng Algorithm	Davias Size	Device Turns	Addama Damaa	
Descriptio	on 6MB Flash	Device Size	Device Type Ext. Flash SPI	Address Range 00200000H - 401FFFFF	EH
			Sta	art: Size:	
		bA		1	:
		Ad		1	:
		Ad		1	

Figure 4-13 Adding GR5xxx\_16MB\_Flash.FLM to Programming Algorithm

(5). Configure RAM for Algorithm, which defines address space to load and implement the programming algorithm. Enter the start address of RAM in GR5525 in the Start input field: 0x20000000. Enter 0xF000 in the Size input field.

RAM for	r Algorithm ——		
Start:	0x20000000	Size: 0xF000	

Figure 4-14 Settings of RAM for Algorithm

- (6). Click **OK** to save the settings.
- 2. Download firmware.

After completing configuration, click 🗰 (**Download**) on the Keil toolbar to download *ble\_app\_example.axf* to Flash. After download is completed, the following results are displayed in the **Build Output** window of Keil.

#### **Note**:

During file download, if **No Cortex-M SW Device Found** pops up, it indicates the SoC may be in sleep state at that moment (the firmware with sleep mode enabled is running), so the .hex file cannot be downloaded to Flash. In this case, developers need to press **RESET** on the GR5525 SK Board and wait for about 1 second; then click **31** (**Download**) to download the file again.



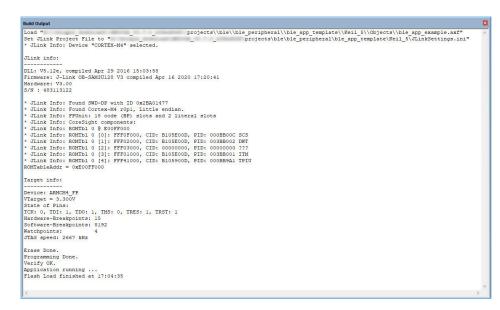


Figure 4-15 Download results

# 4.6 Debugging

Keil provides a debugger for online code debugging. The debugger supports setting six hardware breakpoints and multiple software breakpoints. It also provides developers with multiple methods to set debug commands.

# 4.6.1 Configuring the Debugger

Configure the debugger before debugging. Click **S** (**Options for Target**) on the Keil toolbar, open the **Options for Target 'GRxx\_Soc'** dialog box, and select the **Debug** tab. In the window, software simulation debugging configurations display on the left side, and online hardware debugging configurations display on the right side. Bluetooth LE example projects adopt the online hardware debugging. Related default configurations of the debugger are shown as follows:



🕅 Options for Target 'GRxx_Soc'	×		
Device Target Output Listing User C/C++ Asm	Linker Debug Utilities		
C Use Simulator <u>with restrictions</u> Settings	Use: J-LINK / J-TRACE Cortex     Settings		
Ivadiation Application at Startup     Ivadiation File:	Load Application at Startup Run to main() Initialization File:		
Edit	\\\\build\keil\sram.ini		
Restore Debug Session Settings	Restore Debug Session Settings		
✓ Breakpoints ✓ Toolbox	✓ Breakpoints ✓ Toolbox		
Vatch Windows & Performance Analyzer	✓ Watch Windows		
I         I <thi< th=""> <thi< th=""> <thi< th=""> <thi< th=""></thi<></thi<></thi<></thi<>	I Memory Display I System Viewer		
CPU DLL: Parameter:	Driver DLL: Parameter:		
SARMCM3.DLL -MPU	SARMCM3.DLL -MPU		
Dialog DLL: Parameter:	Dialog DLL: Parameter:		
DCM.DLL pCM4	TCM.DLL PCM4		
Warn if outdated Executable is loaded	Warn if outdated Executable is loaded		
Manage Component Vie	ewer Description Files		
OK Car	ncel Defaults Help		

Figure 4-16 Configuring the debugger

The default initialization file *sram.ini* is in SDK\_Folder\build\keil. You can use this file directly, or copy it to the project directory.

The initialization file *sram.ini* contains a set of debug commands, which are executed during debugging. On the **Initialization File** bar, click **Edit...** on the right side, to open *sram.ini*. Example code of *sram.ini* is provided as follows:

```
/**
* * * * * * * * * * * *
            * GR55xx object loading script through debugger interface
* (e.g.Jlink, *etc).
* The goal of this script is to load the Keils's object file to the
* GR55xx RAM
* assuring that the GR55xx has been previously cleaned up.
*****
                                                          *****
           * * * * * * * * *
                   *****
*/
// Debugger reset(check Keil debugger settings)
// Preselected reset type(found in Options->Debug->Settings)is
// Normal(0);
// -Normal:Reset core & peripherals via SYSRESETREQ & VECTRESET bit
// RESET
// Load object file
LOAD %L
// Load stack pointer
SP = RDWORD(0x0000000)
// Load program counter
= RDWORD(0x0000004)
// Write 0 to vector table register, remap vector
WDWORD(0xE000ED08, 0x0000000)
```

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### 🛄 Note:

Keil supports executing debugger commands set by developers in the following order:

- When Options for Target 'GRxx\_Soc' > Debug > Load Application at Startup is enabled, the debugger first loads the file under Options for Target 'GRxx\_Soc' > Output > Name of Executable.
- 2. Execute the command in the file specified in **Options for Target 'GRxx\_Soc' > Debug > Initialization File**.
- 3. When options under **Options for Target 'GRxx\_Soc' > Debug > Restore Debug Session Settings** are checked, restore corresponding Breakpoints, Watch Windows, Memory Display, and other settings.
- 4. When Options for Target 'GRxx\_Soc' > Debug > Run to main() is checked, or the command g, main is discovered in Initialization File, the debugger automatically starts executing CPU commands, until running to the main() function.

# 4.6.2 Starting Debugging

After completing debugger configuration, click 🔍 (Start/Stop Debug Session) on the Keil toolbar, to start debugging.

### **Note**:

Make sure that both options under **Connect & Reset Options** are set to **Normal**, as shown in Figure 4-17. This is to ensure when you click **Reset** on the Keil toolbar after enabling **Debug Session**, the program can run normally.

Cortex JLink/JTrace Target Driver Setup		×
Debug Trace Flash Download		
J-Link / J-Trace Adapter	SW Device	
SN: 483114462 -	IDCODE Device Name	Move
Device: J-Link OB-SAM3U128	SWD Ox2BA01477 ARM CoreSight SW	-DP Up
HW : V3.00 dll : V6.51a		Down
FW : J-Link OB-SAM3U128 V3 corr		
Port: Max Clock:	Automatic Detection ID CODE:     O Manual Configuration Device Name:	
SW V 5 MHz V		
Auto Clk	Add Delete Update IR len:	
Connect & Reset Options Connect: Normal 💌 Reset: No 🔽 Reset after Connect	mal 🔽 🔽 Cache Code	wnload Options Verify Code Download Download to Flash
Interface     TCP/IP       © USB © TCP/IP     Network S       Scan     IP-Address       State: ready     127	- Autoria	t JLink Info
	ОК	Cancel Apply

Figure 4-17 Setting Connect and Reset to Normal in Connect & Reset Options

# 4.6.3 Outputting Debug Logs

GR5525 SDK provides an APP LOG module and supports outputting debug logs of applications from hardware ports based on customization. Hardware ports include UART, J-Link RTT, and ARM Instrumentation Trace Macrocell (ARM

ITM). To use the APP LOG module, enable APP\_LOG\_ENABLE in *custom\_config.h*, and configure APP\_LOG\_PORT based on the output method as needed.

## 4.6.3.1 Module Initialization

After configuration, you need to call app\_log\_init() during peripheral initialization to initialize the APP LOG module, including setting log parameters, and registering log output APIs and flush APIs.

The APP LOG module supports using printf() (a C standard library function) and APP LOG APIs to output debug logs. If you choose APP LOG APIs, you can optimize logs by setting log level, log format, filter type, or other parameters; if you choose printf(), set log parameters as "NULL".

Call the initialization function of corresponding module (refer to  $SDK_Folder\platform\boards\board_SK$ . h for details) and register corresponding transmission and flush APIs (see bsp\_log\_init() for reference) according to the configured output port. If UART is the output port, bsp\_log\_init() is implemented as follows:

```
void bsp log init (void)
{
#if APP LOG ENABLE
#if (APP LOG PORT == 0)
   bsp uart init();
#elif (APP LOG PORT == 1)
    SEGGER RTT ConfigUpBuffer(0, NULL, NULL, 0, SEGGER RTT MODE BLOCK IF FIFO FULL);
#endif
#if (APP LOG PORT <= 2)</pre>
    app log init t log init;
    log init.filter.level
                                              = APP LOG LVL DEBUG;
    log init.fmt set[APP LOG LVL ERROR] = APP LOG FMT ALL & (~APP LOG FMT TAG);
    log init.fmt set[APP LOG LVL WARNING] = APP LOG FMT LVL;
    log_init.fmt_set[APP_LOG_LVL_INFO] = APP_LOG_FMT_LVL;
log_init.fmt_set[APP_LOG_LVL_DEBUG] = APP_LOG_FMT_LVL;
#if (APP LOG PORT == 0)
    app log init(&log init, bsp uart send, bsp uart flush);
#elif (APP LOG PORT == 1)
    app_log_init(&log_init, bsp_segger_rtt_send, NULL);
#elif (APP LOG PORT == 2)
    app log init(&log init, bsp itm send, NULL);
#endif
#endif
    app assert init();
#endif
}
```

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## 🛄 Note:

- The input parameters of app\_log\_init() include the log initialization parameter, log output API, and flush API (optional for registration).
- GR5525 SDK provides an APP LOG STORE module, which supports storing the debug logs in Flash and outputting the logs from Flash. To use the APP LOG STORE module, users need to enable APP\_LOG\_STORE\_ENABLE in *custom\_config.h.* This module is configured in the ble\_app\_rscs project (in SDK\_Folder\projects\ble\bl e\_peripheral\ble\_app\_rscs). This configuration can be a reference when the APP LOG STORE module is used.
- Application logs output by using printf() cannot be stored by the APP LOG STORE module.

When debug logs are output through UART, the implemented log output API and flush API are bsp\_uart\_send() and bsp\_uart\_flush() respectively.

- bsp\_uart\_send() is the basis for two log output APIs: app\_uart asynchronization (app\_uart\_transmit\_async) and hal\_uart synchronization (hal\_uart\_transmit). Users can choose the output methods as needed.
- bsp\_uart\_flush() is used to output the log data that is cached in memory in interrupt mode.

## Dote:

You can rewrite the above two APIs.

When debug logs are output through J-Link RTT or ARM ITM, the implemented log output API is bsp\_segger\_rtt\_send() or bsp\_itm\_send(). No flush API is to be implemented in the two modes.

# 4.6.3.2 Application

After completing initialization of the APP LOG module, you can use any of the following four APIs to output debug logs:

- APP\_LOG\_ERROR()
- APP\_LOG\_WARNING()
- APP\_LOG\_INFO()
- APP\_LOG\_DEBUG()

In interrupt output mode, call app\_log\_flush() to output all the debug logs cached, to ensure that all debug logs are output before the SoC is reset or the system enters the sleep mode.

If you choose armcc for compilation and output logs through J-Link RTT, it is recommended to make the following modifications in *SEGGER\_RTT.c*:



SEGG	ER_RTT.c
238	*
239	* Static data
240	*
241	***************************************
242	-*/
243	//
244	<pre>// RTT Control Block and allocate buffers for channel 0</pre>
245	//
246	attribute((section (".ARMat_0x20005000"))) SEGGER_RTT_CB _SEGGER_RTT;
247	<pre>//SEGGER_RTT_PUT_CB_SECTION(SEGGER_RTT_CB_ALIGN(SEGGER_RTT_CB _SEGGER_RTT));</pre>
0.40	

Figure 4-18 Creating RTT Control Block and placing it at 0x20005000

The figure below shows the reference configurations for J-Link RTT Viewer.

🔜 J-Link RTT Viewer V6.88a   (	Configuration	?	Х
Connection to J-Link			
USB	Serial No		
O TCP/IP			
O Existing Session			
Specify Target Device			
CORTEX-M4		$\sim$	
Script file (optional)			
Target Interface & Speed			
SWD	•	4000 kH	z 🔻
RTT Control Block			
Address	O Search Range	e	
Enter the address of the RTT Cor Example: 0x20000000	ntrol block.		
0x20005000			
	ОК	Car	ncel

Figure 4-19 Configurations in J-Link RTT Viewer

The address of **RTT Control Block** can be specified by clicking **Address** and then entering a custom value; the input value can be set to the address of the **\_SEGGER\_RTT** structure in the .map file generated by the compiled project, as shown in the figure below. If creating RTT Control Block through the method recommended in Figure 4-18 and placing it at 0x20005000, you need to set **Address** to **0x20005000**.

ultra_wfi_or_wfe	0x200037ec	Data	0	rom_symbol.txt ABSOLUTE
sdk_gap_env	0x200038ec	Data	0	rom_symbol.txt ABSOLUTE
_SEGGER_RTT	0×20005000	Data	120	segger_rtt.o(.ARMat_0x20005000)
jlink_opt_info	0x20006000	Data	0	rom_symbol.txt ABSOLUTE
SystemCoreClock	0x2000b000	Data	4	system_gr55xx.o(.data)
stdout	0x2000b044	Data	4	app_log.o(.data)

Figure 4-20 Obtaining RTT Control Block address



### 🛄 Note:

If you choose GCC for compilation, modifications shown in Figure 4-18 is not required. The address to be entered for RTT Control Block in J-Link RTT Viewer should be the address of **\_SEGGER\_RTT** in the .map file generated by the compilation project.

# 4.6.4 Debugging with GRToolbox

GR5525 SDK provides an Android App, GRToolbox, to debug GR5525 Bluetooth LE applications. GRToolbox features the following:

- General Bluetooth LE scanning and connecting; characteristics read/write
- Demos for standard profiles, including Heart Rate and Blood Pressure
- Goodix-customized applications

### **Tip**:

GRToolbox installation file is in SDK\_Folder\tools\GRToolbox\GRToolbox-Version.apk.

# 5 Glossary

#### Table 5-1 Glossary

Name	Description
AoA/AoD	Angle of Arrival/Angle of Departure
АРІ	Application Programming Interface
ATT	Attribute Protocol
Bluetooth LE	Bluetooth Low Energy
DAP	Debug Access Port
DFU	Device Firmware Update
GAP	Generic Access Profile
GATT	Generic Attribute Profile
GFSK	Gaussian Frequency Shift Keying
HAL	Hardware Abstract Layer
нсі	Host Controller Interface
ют	Internet of Things
L2CAP	Logical Link Control and Adaptation Protocol
LL	Link Layer
NVDS	Non-volatile Data Storage
OTA	Over The Air
PMU	Power Management Unit
РНҮ	Physical Layer
RF	Radio Frequency
SCA	System Configuration Area
SDK	Software Development Kit
SM	Security Manager
SoC	System-on-Chip
UART	Universal Asynchronous Receiver/Transmitter
ХІР	Execute in Place